

# AD9613\* PRODUCT PAGE QUICK LINKS

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- AD9613 Evaluation Board
- AD9643 Evaluation Board

## DOCUMENTATION

### Application Notes

- AN-1142: Techniques for High Speed ADC PCB Layout
- AN-282: Fundamentals of Sampled Data Systems
- AN-345: Grounding for Low-and-High-Frequency Circuits
- AN-501: Aperture Uncertainty and ADC System Performance
- AN-586: LVDS Outputs for High Speed A/D Converters
- AN-737: How ADIsimADC Models an ADC
- AN-741: Little Known Characteristics of Phase Noise
- AN-742: Frequency Domain Response of Switched-Capacitor ADCs
- AN-756: Sampled Systems and the Effects of Clock Phase Noise and Jitter
- AN-807: Multicarrier WCDMA Feasibility
- AN-808: Multicarrier CDMA2000 Feasibility
- AN-827: A Resonant Approach to Interfacing Amplifiers to Switched-Capacitor ADCs
- AN-835: Understanding High Speed ADC Testing and Evaluation
- AN-851: A WiMax Double Downconversion IF Sampling Receiver Design
- AN-878: High Speed ADC SPI Control Software
- AN-905: Visual Analog Converter Evaluation Tool Version 1.0 User Manual
- AN-935: Designing an ADC Transformer-Coupled Front End

### Data Sheet

- AD9613: 12-Bit, 170 MSPS/210 MSPS/250 MSPS, 1.8 V Dual Analog-to-Digital Converter (ADC) Data Sheet

### Technical Books

- The Data Conversion Handbook, 2005

### User Guides

- UG-293: Evaluating the AD9643/AD9613/AD6649/AD6643 Analog-to-Digital Converters

## TOOLS AND SIMULATIONS

- Visual Analog
- AD9613 IBIS Model

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## REFERENCE MATERIALS

### Product Selection Guide

- RF Source Booklet

### Technical Articles

- MS-1779: Nine Often Overlooked ADC Specifications
- MS-2210: Designing Power Supplies for High Speed ADC

### Tutorials

- MT-001: Taking the Mystery out of the Infamous Formula, "SNR=6.02N + 1.76dB", and Why You Should Care
- MT-002: What the Nyquist Criterion Means to Your Sampled Data System Design
- MT-031: Grounding Data Converters and Solving the Mystery of "AGND" and "DGND"
- MT-075: Differential Drivers for High Speed ADCs Overview

## DESIGN RESOURCES

- AD9613 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

## DISCUSSIONS

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### 4/2011—Revision 0: Initial Version

## SPECIFICATIONS

### ADC DC SPECIFICATIONS

AVDD = 1.8 V, DRVDD = 1.8 V, maximum sample rate, VIN = −1.0 dBFS differential input, 1.75 V p-p full scale input range, DCS enabled, unless otherwise noted.

Table 1.

| Parameter                                    | Temp | AD9613-170 |       |       | AD9613-210 |       |         | AD9613-250 |       |           | Unit    |
|----------------------------------------------|------|------------|-------|-------|------------|-------|---------|------------|-------|-----------|---------|
|                                              |      | Min        | Typ   | Max   | Min        | Typ   | Max     | Min        | Typ   | Max       |         |
| RESOLUTION                                   | Full | 12         |       |       | 12         |       |         | 12         |       |           | Bits    |
| ACCURACY                                     |      |            |       |       |            |       |         |            |       |           |         |
| No Missing Codes                             | Full | Guaranteed |       |       | Guaranteed |       |         | Guaranteed |       |           |         |
| Offset Error                                 | Full |            |       | ±10   |            |       | ±10     |            |       | ±10       | mV      |
| Gain Error                                   | Full |            |       | +2/−6 |            |       | +3/−5   |            |       | ±4        | %FSR    |
| Differential Nonlinearity (DNL)              | Full |            |       | ±0.5  |            |       | ±0.5    |            |       | ±0.5      | LSB     |
|                                              | 25°C |            | ±0.25 |       |            | ±0.25 |         |            | ±0.25 |           | LSB     |
| Integral Nonlinearity (INL) <sup>1</sup>     | Full |            |       | ±0.5  |            |       | ±0.6    |            |       | ±0.8      | LSB     |
|                                              | 25°C |            | ±0.20 |       |            | ±0.25 |         |            | ±0.28 |           | LSB     |
| MATCHING CHARACTERISTIC                      |      |            |       |       |            |       |         |            |       |           |         |
| Offset Error                                 | Full |            |       | ±13   |            |       | ±13     |            |       | ±13       | mV      |
| Gain Error                                   | Full |            |       | ±2.5  |            |       | +3.5/−2 |            |       | +3.5/−2.5 | %FSR    |
| TEMPERATURE DRIFT                            |      |            |       |       |            |       |         |            |       |           |         |
| Offset Error                                 | Full |            | ±5    |       |            | ±5    |         |            | ±5    |           | ppm/°C  |
| Gain Error                                   | Full |            | ±70   |       |            | ±80   |         |            | ±100  |           | ppm/°C  |
| INPUT-REFERRED NOISE                         |      |            |       |       |            |       |         |            |       |           |         |
| VREF = 1.75 V                                | 25°C |            | 0.39  |       |            | 0.39  |         |            | 0.39  |           | LSB rms |
| ANALOG INPUT                                 |      |            |       |       |            |       |         |            |       |           |         |
| Input Span                                   | Full |            | 1.75  |       |            | 1.75  |         |            | 1.75  |           | V p-p   |
| Input Capacitance <sup>2</sup>               | Full |            | 2.5   |       |            | 2.5   |         |            | 2.5   |           | pF      |
| Input Resistance <sup>3</sup>                | Full |            | 20    |       |            | 20    |         |            | 20    |           | kΩ      |
| Input Common-Mode Voltage                    | Full |            | 0.9   |       |            | 0.9   |         |            | 0.9   |           | V       |
| POWER SUPPLIES                               |      |            |       |       |            |       |         |            |       |           |         |
| Supply Voltage                               |      |            |       |       |            |       |         |            |       |           |         |
| AVDD                                         | Full | 1.7        | 1.8   | 1.9   | 1.7        | 1.8   | 1.9     | 1.7        | 1.8   | 1.9       | V       |
| DRVDD                                        | Full | 1.7        | 1.8   | 1.9   | 1.7        | 1.8   | 1.9     | 1.7        | 1.8   | 1.9       | V       |
| Supply Current                               |      |            |       |       |            |       |         |            |       |           |         |
| I <sub>AVDD</sub> <sup>1</sup>               | Full |            | 230   | 250   |            | 241   | 265     |            | 252   | 275       | mA      |
| I <sub>DRVDD</sub> <sup>1</sup>              | Full |            | 142   | 160   |            | 159   | 185     |            | 176   | 210       | mA      |
| POWER CONSUMPTION                            |      |            |       |       |            |       |         |            |       |           |         |
| Sine Wave Input <sup>1</sup> (DRVDD = 1.8 V) | Full |            | 670   | 738   |            | 720   | 810     |            | 770   | 873       | mW      |
| Standby Power <sup>4</sup>                   | Full |            | 90    |       |            | 90    |         |            | 90    |           | mW      |
| Power-Down Power                             | Full |            | 10    |       |            | 10    |         |            | 10    |           | mW      |

<sup>1</sup> Measured with a low input frequency, full-scale sine wave.

<sup>2</sup> Input capacitance refers to the effective capacitance between one differential input pin and its complement.

<sup>3</sup> Input resistance refers to the effective resistance between one differential input pin and its complement.

<sup>4</sup> Standby power is measured with a dc input and the CLK± pin inactive (that is, set to AVDD or AGND).

## ADC AC SPECIFICATIONS

AVDD = 1.8 V, DRVDD = 1.8 V, maximum sample rate, VIN = –1.0 dBFS differential input, 1.75 V p-p full scale input range, unless otherwise noted.

Table 2.

| Parameter <sup>1</sup>                 | Temp | AD9613-170 |      |     | AD9613-210 |      |     | AD9613-250 |      |     | Unit |
|----------------------------------------|------|------------|------|-----|------------|------|-----|------------|------|-----|------|
|                                        |      | Min        | Typ  | Max | Min        | Typ  | Max | Min        | Typ  | Max |      |
| SIGNAL-TO-NOISE-RATIO (SNR)            |      |            |      |     |            |      |     |            |      |     |      |
| f <sub>IN</sub> = 30 MHz               | 25°C |            | 70.1 |     |            | 70.1 |     |            | 70.0 |     | dBFS |
| f <sub>IN</sub> = 90 MHz               | 25°C |            | 70.0 |     |            | 70.0 |     |            | 69.8 |     | dBFS |
|                                        | Full | 69.3       |      |     | 69.2       |      |     |            |      |     | dBFS |
| f <sub>IN</sub> = 140 MHz              | 25°C |            | 69.8 |     |            | 69.8 |     |            | 69.6 |     | dBFS |
| f <sub>IN</sub> = 185 MHz              | 25°C |            | 69.5 |     |            | 69.5 |     |            | 69.2 |     | dBFS |
|                                        | Full |            |      |     |            |      |     | 67.8       |      |     | dBFS |
| f <sub>IN</sub> = 220 MHz              | 25°C |            | 69.4 |     |            | 69.3 |     |            | 69.0 |     | dBFS |
| SIGNAL-TO-NOISE AND DISTORTION (SINAD) |      |            |      |     |            |      |     |            |      |     |      |
| f <sub>IN</sub> = 30 MHz               | 25°C |            | 69.1 |     |            | 69.1 |     |            | 69.0 |     | dBFS |
| f <sub>IN</sub> = 90 MHz               | 25°C |            | 69.0 |     |            | 69.0 |     |            | 68.8 |     | dBFS |
|                                        | Full | 68.2       |      |     | 68         |      |     |            |      |     | dBFS |
| f <sub>IN</sub> = 140 MHz              | 25°C |            | 68.8 |     |            | 68.8 |     |            | 68.6 |     | dBFS |
| f <sub>IN</sub> = 185 MHz              | 25°C |            | 68.5 |     |            | 68.5 |     |            | 68.2 |     | dBFS |
|                                        | Full |            |      |     |            |      |     | 66.5       |      |     | dBFS |
| f <sub>IN</sub> = 220 MHz              | 25°C |            | 68.4 |     |            | 68.3 |     |            | 68.0 |     | dBFS |
| EFFECTIVE NUMBER OF BITS (ENOB)        |      |            |      |     |            |      |     |            |      |     |      |
| f <sub>IN</sub> = 30 MHz               | 25°C |            | 11.2 |     |            | 11.2 |     |            | 11.2 |     | Bits |
| f <sub>IN</sub> = 90 MHz               | 25°C |            | 11.2 |     |            | 11.2 |     |            | 11.1 |     | Bits |
| f <sub>IN</sub> = 140 MHz              | 25°C |            | 11.1 |     |            | 11.1 |     |            | 11.1 |     | Bits |
| f <sub>IN</sub> = 185 MHz              | 25°C |            | 11.1 |     |            | 11.1 |     |            | 11.0 |     | Bits |
| f <sub>IN</sub> = 220 MHz              | 25°C |            | 11.1 |     |            | 11.0 |     |            | 11.0 |     | Bits |
| WORST SECOND OR THIRD HARMONIC         |      |            |      |     |            |      |     |            |      |     |      |
| f <sub>IN</sub> = 30 MHz               | 25°C |            | −94  |     |            | −94  |     |            | −90  |     | dBc  |
| f <sub>IN</sub> = 90 MHz               | 25°C |            | −92  |     |            | −94  |     |            | −89  |     | dBc  |
|                                        | Full |            |      | −78 |            |      | −80 |            |      |     | dBc  |
| f <sub>IN</sub> = 140 MHz              | 25°C |            | −87  |     |            | −88  |     |            | −86  |     | dBc  |
| f <sub>IN</sub> = 185 MHz              | 25°C |            | −89  |     |            | −83  |     |            | −86  |     | dBc  |
|                                        | Full |            |      |     |            |      |     |            | −80  |     | dBc  |
| f <sub>IN</sub> = 220 MHz              | 25°C |            | −80  |     |            | −83  |     |            | −85  |     | dBc  |
| SPURIOUS-FREE DYNAMIC RANGE (SFDR)     |      |            |      |     |            |      |     |            |      |     |      |
| f <sub>IN</sub> = 30 MHz               | 25°C |            | 94   |     |            | 90   |     |            | 92   |     | dBc  |
| f <sub>IN</sub> = 90 MHz               | 25°C |            | 92   |     |            | 90   |     |            | 89   |     | dBc  |
|                                        | Full | 78         |      |     | 80         |      |     |            |      |     | dBc  |
| f <sub>IN</sub> = 140 MHz              | 25°C |            | 87   |     |            | 88   |     |            | 86   |     | dBc  |
| f <sub>IN</sub> = 185 MHz              | 25°C |            | 89   |     |            | 83   |     |            | 86   |     | dBc  |
|                                        | Full |            |      |     |            |      |     | 80         |      |     | dBc  |
| f <sub>IN</sub> = 220 MHz              | 25°C |            | 83   |     |            | 83   |     |            | 85   |     | dBc  |
| WORST OTHER (HARMONIC OR SPUR)         |      |            |      |     |            |      |     |            |      |     |      |
| f <sub>IN</sub> = 30 MHz               | 25°C |            | −97  |     |            | −95  |     |            | −93  |     | dBc  |
| f <sub>IN</sub> = 90 MHz               | 25°C |            | −96  |     |            | −95  |     |            | −92  |     | dBc  |
|                                        | Full |            |      | −78 |            |      | −80 |            |      |     | dBc  |
| f <sub>IN</sub> = 140 MHz              | 25°C |            | −97  |     |            | −97  |     |            | −91  |     | dBc  |
| f <sub>IN</sub> = 185 MHz              | 25°C |            | −91  |     |            | −96  |     |            | −91  |     | dBc  |
|                                        | Full |            |      |     |            |      |     |            | −80  |     | dBc  |
| f <sub>IN</sub> = 220 MHz              | 25°C |            | −93  |     |            | −94  |     |            | −89  |     | dBc  |

| Parameter <sup>1</sup>                                                                                        | Temp | AD9613-170 |      |     | AD9613-210 |      |     | AD9613-250 |      |     | Unit |
|---------------------------------------------------------------------------------------------------------------|------|------------|------|-----|------------|------|-----|------------|------|-----|------|
|                                                                                                               |      | Min        | Typ  | Max | Min        | Typ  | Max | Min        | Typ  | Max |      |
| TWO-TONE SFDR<br>$f_{IN} = 184.12 \text{ MHz } (-7 \text{ dBFS}),$<br>$187.12 \text{ MHz } (-7 \text{ dBFS})$ | 25°C |            | 88   |     |            | 88   |     |            | 88   |     | dBc  |
| CROSSTALK <sup>2</sup>                                                                                        | Full |            | 95   |     |            | 95   |     |            | 95   |     | dB   |
| FULL POWER BANDWIDTH <sup>3</sup>                                                                             | 25°C |            | 1000 |     |            | 1000 |     |            | 1000 |     | MHz  |

<sup>1</sup> See the [AN-835](#) Application Note, *Understanding High Speed ADC Testing and Evaluation*, for a complete set of definitions.

<sup>2</sup> Crosstalk is measured at 100 MHz with  $-1.0 \text{ dBFS}$  on one channel and no input on the alternate channel.

<sup>3</sup> Full power bandwidth is the bandwidth of operation where typical ADC performance can be achieved.

**DIGITAL SPECIFICATIONS**

AVDD = 1.8 V, DRVDD = 1.8 V, maximum sample rate, VIN = –1.0 dBFS differential input, 1.75 V p-p full-scale input range, DCS enabled, unless otherwise noted.

**Table 3.**

| Parameter                                     | Temp | Min              | Typ | Max  | Unit  |
|-----------------------------------------------|------|------------------|-----|------|-------|
| <b>DIFFERENTIAL CLOCK INPUTS (CLK+, CLK–)</b> |      |                  |     |      |       |
| Logic Compliance                              |      | CMOS/LVDS/LVPECL |     |      |       |
| Internal Common-Mode Bias                     | Full |                  | 0.9 |      | V     |
| Differential Input Voltage                    | Full | 0.3              |     | 3.6  | V p-p |
| Input Voltage Range                           | Full | AGND             |     | AVDD | V     |
| Input Common-Mode Range                       | Full | 0.9              |     | 1.4  | V     |
| High Level Input Current                      | Full | 10               |     | 22   | μA    |
| Low Level Input Current                       | Full | –22              |     | –10  | μA    |
| Input Capacitance                             | Full |                  | 4   |      | pF    |
| Input Resistance                              | Full | 8                | 10  | 12   | kΩ    |
| <b>SYNC INPUT</b>                             |      |                  |     |      |       |
| Logic Compliance                              |      | CMOS/LVDS        |     |      |       |
| Internal Bias                                 | Full |                  | 0.9 |      | V     |
| Input Voltage Range                           | Full | AGND             |     | AVDD | V     |
| High Level Input Voltage                      | Full | 1.2              |     | AVDD | V     |
| Low Level Input Voltage                       | Full | AGND             |     | 0.6  | V     |
| High Level Input Current                      | Full | –5               |     | +5   | μA    |
| Low Level Input Current                       | Full | –5               |     | +5   | μA    |
| Input Capacitance                             | Full |                  | 1   |      | pF    |
| Input Resistance                              | Full | 12               | 16  | 20   | kΩ    |
| <b>LOGIC INPUT (CSB)<sup>1</sup></b>          |      |                  |     |      |       |
| High Level Input Voltage                      | Full | 1.22             |     | 2.1  | V     |
| Low Level Input Voltage                       | Full | 0                |     | 0.6  | V     |
| High Level Input Current                      | Full | –5               |     | +5   | μA    |
| Low Level Input Current                       | Full | –80              |     | +45  | μA    |
| Input Resistance                              | Full |                  | 26  |      | kΩ    |
| Input Capacitance                             | Full |                  | 2   |      | pF    |
| <b>LOGIC INPUT (SCLK)<sup>2</sup></b>         |      |                  |     |      |       |
| High Level Input Voltage                      | Full | 1.22             |     | 2.1  | V     |
| Low Level Input Voltage                       | Full | 0                |     | 0.6  | V     |
| High Level Input Current                      | Full | 45               |     | 70   | μA    |
| Low Level Input Current                       | Full | –5               |     | +5   | μA    |
| Input Resistance                              | Full |                  | 26  |      | kΩ    |
| Input Capacitance                             | Full |                  | 2   |      | pF    |
| <b>LOGIC INPUTS (SDIO)<sup>2</sup></b>        |      |                  |     |      |       |
| High Level Input Voltage                      | Full | 1.22             |     | 2.1  | V     |
| Low Level Input Voltage                       | Full | 0                |     | 0.6  | V     |
| High Level Input Current                      | Full | 45               |     | 70   | μA    |
| Low Level Input Current                       | Full | –5               |     | +5   | μA    |
| Input Resistance                              | Full |                  | 26  |      | kΩ    |
| Input Capacitance                             | Full |                  | 5   |      | pF    |

| Parameter                                                    | Temp | Min  | Typ  | Max  | Unit |
|--------------------------------------------------------------|------|------|------|------|------|
| LOGIC INPUTS (OEB, PDWN) <sup>2</sup>                        |      |      |      |      |      |
| High Level Input Voltage                                     | Full | 1.22 |      | 2.1  | V    |
| Low Level Input Voltage                                      | Full | 0    |      | 0.6  | V    |
| High Level Input Current                                     | Full | 45   |      | 70   | μA   |
| Low Level Input Current                                      | Full | −5   |      | +5   | μA   |
| Input Resistance                                             | Full |      | 26   |      | kΩ   |
| Input Capacitance                                            | Full |      | 5    |      | pF   |
| DIGITAL OUTPUTS                                              |      |      |      |      |      |
| LVDS Data and OR Outputs                                     |      |      |      |      |      |
| Differential Output Voltage ( $V_{OD}$ ), ANSI Mode          | Full | 250  | 350  | 450  | mV   |
| Output Offset Voltage ( $V_{OS}$ ), ANSI Mode                | Full | 1.15 | 1.22 | 1.35 | V    |
| Differential Output Voltage ( $V_{OD}$ ), Reduced Swing Mode | Full | 150  | 200  | 280  | mV   |
| Output Offset Voltage ( $V_{OS}$ ), Reduced Swing Mode       | Full | 1.15 | 1.22 | 1.35 | V    |

<sup>1</sup> Pull up.<sup>2</sup> Pull down.

## SWITCHING SPECIFICATIONS

Table 4.

| Parameter                                        | Temp | AD9613-170 |     |      | AD9613-210 |     |      | AD9613-250 |     |     | Unit   |
|--------------------------------------------------|------|------------|-----|------|------------|-----|------|------------|-----|-----|--------|
|                                                  |      | Min        | Typ | Max  | Min        | Typ | Max  | Min        | Typ | Max |        |
| CLOCK INPUT PARAMETERS                           |      |            |     |      |            |     |      |            |     |     |        |
| Input Clock Rate                                 | Full |            |     | 625  |            |     | 625  |            |     | 625 | MHz    |
| Conversion Rate <sup>1</sup>                     | Full | 40         |     | 170  | 40         |     | 210  | 40         |     | 250 | MSPS   |
| CLK Period, Divide-by-1 Mode (t <sub>CLK</sub> ) | Full | 5.8        |     |      | 4.8        |     |      | 4          |     |     | ns     |
| CLK Pulse Width High (t <sub>CH</sub> )          |      |            |     |      |            |     |      |            |     |     |        |
| Divide-by-1 Mode, DCS Enabled                    | Full | 2.61       | 2.9 | 3.19 | 2.16       | 2.4 | 2.64 | 1.8        | 2.0 | 2.2 | ns     |
| Divide-by-1 Mode, DCS Disabled                   | Full | 2.76       | 2.9 | 3.05 | 2.28       | 2.4 | 2.52 | 1.9        | 2.0 | 2.1 | ns     |
| Divide-by-2 Mode Through Divide-by-8 Mode        | Full | 0.8        |     |      | 0.8        |     |      | 0.8        |     |     | ns     |
| Aperture Delay (t <sub>A</sub> )                 | Full |            | 1.0 |      |            | 1.0 |      |            | 1.0 |     | ns     |
| Aperture Uncertainty (Jitter, t <sub>J</sub> )   | Full |            | 0.1 |      |            | 0.1 |      |            | 0.1 |     | ps rms |
| DATA OUTPUT PARAMETERS                           |      |            |     |      |            |     |      |            |     |     |        |
| LVDS Mode                                        |      |            |     |      |            |     |      |            |     |     |        |
| Data Propagation Delay (t <sub>PD</sub> )        | Full |            | 6.0 |      |            | 6.0 |      |            | 6.0 |     | ns     |
| DCO Propagation Delay (t <sub>DCO</sub> )        | Full |            | 6.7 |      |            | 6.7 |      |            | 6.7 |     | ns     |
| DCO to Data Skew (t <sub>SKEW</sub> )            | Full | 0.4        | 0.7 | 1.0  | 0.4        | 0.7 | 1.0  | 0.4        | 0.7 | 1.0 | ns     |
| Pipeline Delay (Latency)                         | Full |            | 10  |      |            | 10  |      |            | 10  |     | Cycles |
| Aperture Delay (t <sub>A</sub> )                 | Full |            | 1.0 |      |            | 1.0 |      |            | 1.0 |     | ns     |
| Aperture Uncertainty (Jitter, t <sub>J</sub> )   | Full |            | 0.1 |      |            | 0.1 |      |            | 0.1 |     | ps rms |
| Wake-Up Time (from Standby)                      | Full |            | 10  |      |            | 10  |      |            | 10  |     | μs     |
| Wake-Up Time (from Power Down)                   | Full |            | 250 |      |            | 250 |      |            | 250 |     | μs     |
| Out-of-Range Recovery Time                       | Full |            |     | 3    |            | 3   |      |            | 3   |     | Cycles |

<sup>1</sup> Conversion rate is the clock rate after the divider.

## TIMING SPECIFICATIONS

Table 5.

| Parameter                | Test Conditions/Comments                                                                                                       | Min | Typ | Max | Unit |
|--------------------------|--------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| SYNC TIMING REQUIREMENTS | See Figure 3 for timing details                                                                                                |     |     |     |      |
| t <sub>SSYNC</sub>       | SYNC to the rising edge of CLK setup time                                                                                      |     | 0.3 |     | ns   |
| t <sub>HSYNC</sub>       | SYNC to the rising edge of CLK hold time                                                                                       |     | 0.4 |     | ns   |
| SPI TIMING REQUIREMENTS  | See Figure 58 for SPI timing diagram                                                                                           |     |     |     |      |
| t <sub>DS</sub>          | Setup time between the data and the rising edge of SCLK                                                                        | 2   |     |     | ns   |
| t <sub>DH</sub>          | Hold time between the data and the rising edge of SCLK                                                                         | 2   |     |     | ns   |
| t <sub>CLK</sub>         | Period of the SCLK                                                                                                             | 40  |     |     | ns   |
| t <sub>S</sub>           | Setup time between CSB and SCLK                                                                                                | 2   |     |     | ns   |
| t <sub>H</sub>           | Hold time between CSB and SCLK                                                                                                 | 2   |     |     | ns   |
| t <sub>HIGH</sub>        | Minimum period that SCLK should be in a logic high state                                                                       | 10  |     |     | ns   |
| t <sub>LOW</sub>         | Minimum period that SCLK should be in a logic low state                                                                        | 10  |     |     | ns   |
| t <sub>EN_SDIO</sub>     | Time required for the SDIO pin to switch from an input to an output relative to the SCLK falling edge (not shown in Figure 58) | 10  |     |     | ns   |
| t <sub>DIS_SDIO</sub>    | Time required for the SDIO pin to switch from an output to an input relative to the SCLK rising edge (not shown in Figure 58)  | 10  |     |     | ns   |

Timing Diagrams

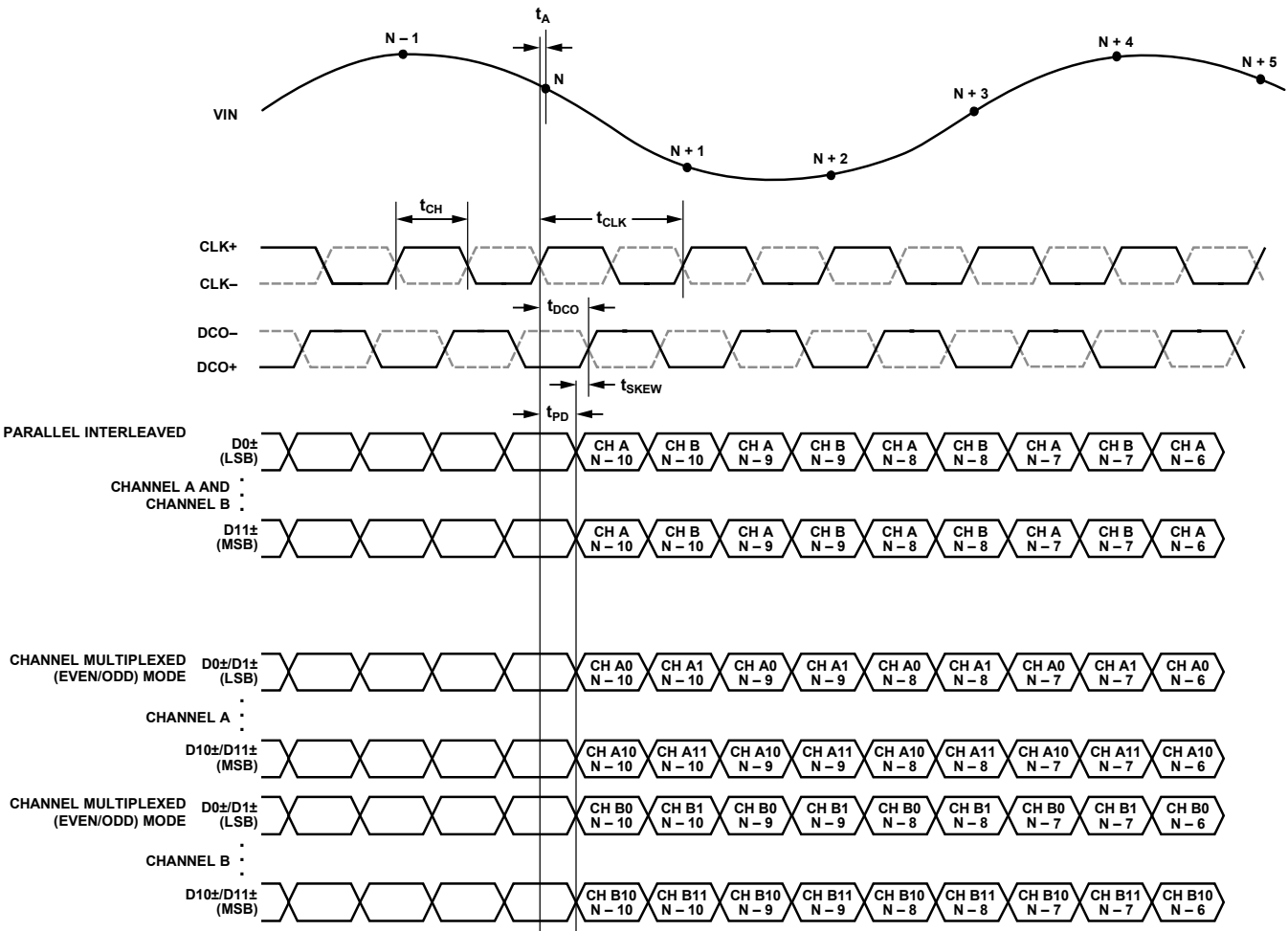


Figure 2. Interleaved LVDS Mode Data Output Timing

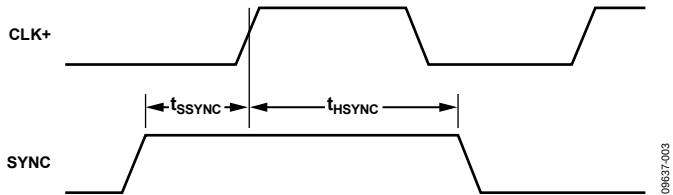


Figure 3. SYNC Timing Inputs

09637-002

09637-003

## ABSOLUTE MAXIMUM RATINGS

Table 6.

| Parameter                               | Rating                  |
|-----------------------------------------|-------------------------|
| Electrical                              |                         |
| AVDD to AGND                            | −0.3 V to +2.0 V        |
| DRVDD to AGND                           | −0.3 V to +2.0 V        |
| VIN+A/VIN+B, VIN−A/VIN−B to AGND        | −0.3 V to AVDD + 0.2 V  |
| CLK+, CLK− to AGND                      | −0.3 V to AVDD + 0.2 V  |
| SYNC to AGND                            | −0.3 V to AVDD + 0.2 V  |
| VCM to AGND                             | −0.3 V to AVDD + 0.2 V  |
| CSB to AGND                             | −0.3 V to DRVDD + 0.3 V |
| SCLK to AGND                            | −0.3 V to DRVDD + 0.3 V |
| SDIO to AGND                            | −0.3 V to DRVDD + 0.3 V |
| OEB to AGND                             | −0.3 V to DRVDD + 0.3 V |
| PDWN to AGND                            | −0.3 V to DRVDD + 0.3 V |
| OR+/OR− to AGND                         | −0.3 V to DRVDD + 0.3 V |
| D0−/D0+ Through D11−/D11+ to AGND       | −0.3 V to DRVDD + 0.3 V |
| DCO+/DCO− to AGND                       | −0.3 V to DRVDD + 0.3 V |
| Environmental                           |                         |
| Operating Temperature Range (Ambient)   | −40°C to +85°C          |
| Maximum Junction Temperature Under Bias | 150°C                   |
| Storage Temperature Range (Ambient)     | −65°C to +125°C         |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## THERMAL CHARACTERISTICS

The exposed paddle must be soldered to the ground plane for the LFCSP package. Soldering the exposed paddle to the printed circuit board (PCB) increases the reliability of the solder joints, maximizing the thermal capability of the package.

Typical  $\theta_{JA}$  is specified for a 4-layer PCB with solid ground plane. As shown in Figure 40, airflow increases heat dissipation, which reduces  $\theta_{JA}$ . In addition, metal in direct contact with the package leads from metal traces, through holes, ground, and power planes reduces the  $\theta_{JA}$ .

Table 7. Thermal Resistance

| Package Type                              | Airflow Velocity (m/sec) | $\theta_{JA}^{1,2}$ | $\theta_{JC}^{1,3}$ | $\theta_{JB}^{1,4}$ | Unit |
|-------------------------------------------|--------------------------|---------------------|---------------------|---------------------|------|
| 64-Lead LFCSP<br>9 mm × 9 mm<br>(CP-64-4) | 0                        | 26.8                | 1.14                | 10.4                | °C/W |
|                                           | 1.0                      | 21.6                |                     |                     | °C/W |
|                                           | 2.0                      | 20.2                |                     |                     | °C/W |

<sup>1</sup> Per JEDEC 51-7, plus JEDEC 25-5 2S2P test board.

<sup>2</sup> Per JEDEC JESD51-2 (still air) or JEDEC JESD51-6 (moving air).

<sup>3</sup> Per MIL-Std 883, Method 1012.1.

<sup>4</sup> Per JEDEC JESD51-8 (still air).

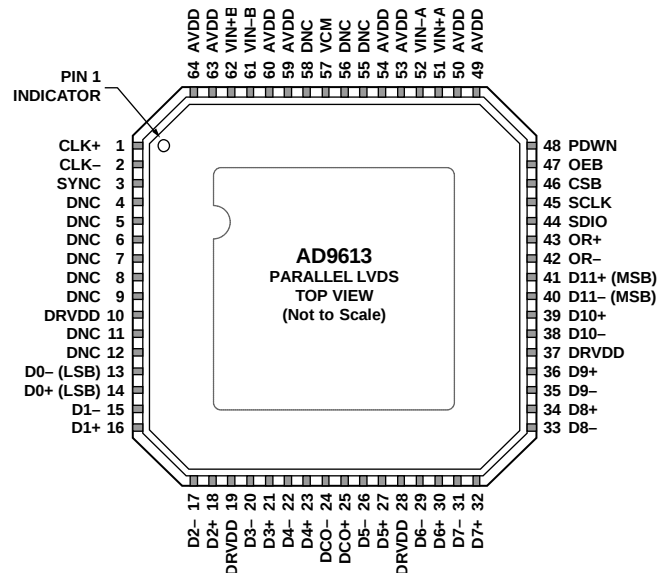
## ESD CAUTION



### ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



## NOTES

1. DNC = DO NOT CONNECT. DO NOT CONNECT TO THIS PIN.
2. THE EXPOSED THERMAL PADDLE ON THE BOTTOM OF THE PACKAGE PROVIDES THE ANALOG GROUND FOR THE PART. THIS EXPOSED PADDLE MUST BE CONNECTED TO GROUND FOR PROPER OPERATION.

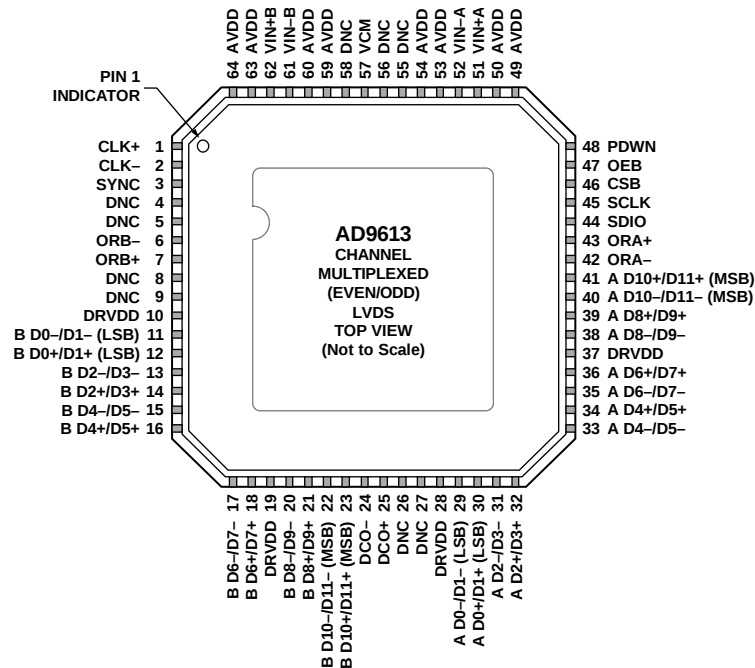
09637-004

Figure 4. Pin Configuration (Top View) for the LFCSP Interleaved Parallel LVDS Mode

Table 8. Pin Function Descriptions for the LFCSP Interleaved Parallel LVDS Mode

| Pin No.                        | Mnemonic                | Type   | Description                                                                                                                                                                           |
|--------------------------------|-------------------------|--------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ADC Power Supplies             |                         |        |                                                                                                                                                                                       |
| 0                              | AGND,<br>Exposed Paddle | Ground | Analog Ground. The exposed thermal paddle on the bottom of the package provides the analog ground for the part. This exposed paddle must be connected to ground for proper operation. |
| 4 to 9, 11, 12, 55, 56, 58     | DNC                     |        | Do not connect. Do not connect to these pins.                                                                                                                                         |
| 10, 19, 28, 37                 | DRVDD                   | Supply | Digital Output Driver Supply (1.8 V Nominal).                                                                                                                                         |
| 49, 50, 53, 54, 59, 60, 63, 64 | AVDD                    | Supply | Analog Power Supply (1.8 V Nominal).                                                                                                                                                  |
| ADC Analog                     |                         |        |                                                                                                                                                                                       |
| 1                              | CLK+                    | Input  | ADC Clock Input—True.                                                                                                                                                                 |
| 2                              | CLK-                    | Input  | ADC Clock Input—Complement.                                                                                                                                                           |
| 51                             | VIN+A                   | Input  | Differential Analog Input Pin (+) for Channel A.                                                                                                                                      |
| 52                             | VIN-A                   | Input  | Differential Analog Input Pin (-) for Channel A.                                                                                                                                      |
| 57                             | VCM                     | Output | Common-Mode Level Bias Output for Analog Inputs. This pin should be decoupled to ground using a 0.1 $\mu$ F capacitor.                                                                |
| 61                             | VIN-B                   | Input  | Differential Analog Input Pin (-) for Channel B.                                                                                                                                      |
| 62                             | VIN+B                   | Input  | Differential Analog Input Pin (+) for Channel B.                                                                                                                                      |
| Digital Input                  |                         |        |                                                                                                                                                                                       |
| 3                              | SYNC                    | Input  | Digital Synchronization Pin. Slave mode only.                                                                                                                                         |

| Pin No.                                 | Mnemonic   | Type         | Description                                                                                                                                                         |
|-----------------------------------------|------------|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Digital Outputs</b>                  |            |              |                                                                                                                                                                     |
| 14                                      | D0+ (LSB)  | Output       | Channel A/Channel B LVDS Output Data 0—True.                                                                                                                        |
| 13                                      | D0– (LSB)  | Output       | Channel A/Channel B LVDS Output Data 0—Complement.                                                                                                                  |
| 16                                      | D1+        | Output       | Channel A/Channel B LVDS Output Data 1—True.                                                                                                                        |
| 15                                      | D1–        | Output       | Channel A/Channel B LVDS Output Data 1—Complement.                                                                                                                  |
| 18                                      | D2+        | Output       | Channel A/Channel B LVDS Output Data 2—True.                                                                                                                        |
| 17                                      | D2–        | Output       | Channel A/Channel B LVDS Output Data 2—Complement.                                                                                                                  |
| 21                                      | D3+        | Output       | Channel A/Channel B LVDS Output Data 3—True.                                                                                                                        |
| 20                                      | D3–        | Output       | Channel A/Channel B LVDS Output Data 3—Complement.                                                                                                                  |
| 23                                      | D4+        | Output       | Channel A/Channel B LVDS Output Data 4—True.                                                                                                                        |
| 22                                      | D4–        | Output       | Channel A/Channel B LVDS Output Data 4—Complement.                                                                                                                  |
| 27                                      | D5+        | Output       | Channel A/Channel B LVDS Output Data 5—True.                                                                                                                        |
| 26                                      | D5–        | Output       | Channel A/Channel B LVDS Output Data 5—Complement.                                                                                                                  |
| 30                                      | D6+        | Output       | Channel A/Channel B LVDS Output Data 6—True.                                                                                                                        |
| 29                                      | D6–        | Output       | Channel A/Channel B LVDS Output Data 6—Complement.                                                                                                                  |
| 32                                      | D7+        | Output       | Channel A/Channel B LVDS Output Data 7—True.                                                                                                                        |
| 31                                      | D7–        | Output       | Channel A/Channel B LVDS Output Data 7—Complement.                                                                                                                  |
| 34                                      | D8+        | Output       | Channel A/Channel B LVDS Output Data 8—True.                                                                                                                        |
| 33                                      | D8–        | Output       | Channel A/Channel B LVDS Output Data 8—Complement.                                                                                                                  |
| 36                                      | D9+        | Output       | Channel A/Channel B LVDS Output Data 9—True.                                                                                                                        |
| 35                                      | D9–        | Output       | Channel A/Channel B LVDS Output Data 9—Complement.                                                                                                                  |
| 39                                      | D10+       | Output       | Channel A/Channel B LVDS Output Data 10—True.                                                                                                                       |
| 38                                      | D10–       | Output       | Channel A/Channel B LVDS Output Data 10—Complement.                                                                                                                 |
| 41                                      | D11+ (MSB) | Output       | Channel A/Channel B LVDS Output Data 11—True.                                                                                                                       |
| 40                                      | D11– (MSB) | Output       | Channel A/Channel B LVDS Output Data 11—Complement.                                                                                                                 |
| 43                                      | OR+        | Output       | Channel A/Channel B LVDS Overage—True.                                                                                                                              |
| 42                                      | OR–        | Output       | Channel A/Channel B LVDS Overage—Complement.                                                                                                                        |
| 25                                      | DCO+       | Output       | Channel A/Channel B LVDS Data Clock Output—True.                                                                                                                    |
| 24                                      | DCO–       | Output       | Channel A/Channel B LVDS Data Clock Output—Complement.                                                                                                              |
| <b>SPI Control</b>                      |            |              |                                                                                                                                                                     |
| 45                                      | SCLK       | Input        | SPI Serial Clock.                                                                                                                                                   |
| 44                                      | SDIO       | Input/Output | SPI Serial Data I/O.                                                                                                                                                |
| 46                                      | CSB        | Input        | SPI Chip Select (Active Low).                                                                                                                                       |
| <b>Output Enable Bar and Power-Down</b> |            |              |                                                                                                                                                                     |
| 47                                      | OEB        | Input/Output | Output Enable Bar Input (Active Low).                                                                                                                               |
| 48                                      | PDWN       | Input/Output | Power-Down Input (Active High). Operation depends upon SPI mode; this input can be configured as power-down or standby. For further description, refer to Table 14. |



## NOTES

1. DNC = DO NOT CONNECT. DO NOT CONNECT TO THIS PIN.
2. THE EXPOSED THERMAL PADDLE ON THE BOTTOM OF THE PACKAGE PROVIDES THE ANALOG GROUND FOR THE PART. THIS EXPOSED PADDLE MUST BE CONNECTED TO GROUND FOR PROPER OPERATION.

09637-005

Figure 5. Pin Configuration (Top View) for the LFCSP Channel Multiplexed (Even/Odd) LVDS Mode

Table 9. Pin Function Descriptions for the LFCSP Channel Multiplexed (Even/Odd) LVDS Mode

| Pin No.                                                                                                       | Mnemonic                                                    | Type                                                             | Description                                                                                                                                                                                                                                                                                                                                                                                        |
|---------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------|------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ADC Power Supplies<br>10, 19, 28, 37<br>49, 50, 53, 54, 59, 60, 63, 64<br>4, 5, 8, 9, 26, 27, 55, 56, 58<br>0 | DRVDD<br>AVDD<br>DNC<br>AGND, Exposed Paddle                | Supply<br>Supply<br><br>Ground                                   | Digital Output Driver Supply (1.8 V Nominal).<br>Analog Power Supply (1.8 V Nominal).<br>Do Not Connect. Do not connect to these pins.<br>The exposed thermal paddle on the bottom of the package provides the analog ground for the part. This exposed paddle must be connected to ground for proper operation.                                                                                   |
| ADC Analog<br>51<br>52<br>62<br>61<br>57<br><br>1<br>2                                                        | VIN+A<br>VIN-A<br>VIN+B<br>VIN-B<br>VCM<br><br>CLK+<br>CLK- | Input<br>Input<br>Input<br>Input<br>Output<br><br>Input<br>Input | Differential Analog Input Pin (+) for Channel A.<br>Differential Analog Input Pin (-) for Channel A.<br>Differential Analog Input Pin (+) for Channel B.<br>Differential Analog Input Pin (-) for Channel B.<br>Common-Mode Level Bias Output for Analog Inputs. This pin should be decoupled to ground using a 0.1 $\mu$ F capacitor.<br><br>ADC Clock Input—True.<br>ADC Clock Input—Complement. |
| Digital Input<br>3                                                                                            | SYNC                                                        | Input                                                            | Digital Synchronization Pin. Slave mode only.                                                                                                                                                                                                                                                                                                                                                      |
| Digital Outputs<br>7<br><br>6                                                                                 | ORB+<br><br>ORB-                                            | Output<br><br>Output                                             | Channel B LVDS Overrange Output—True. The overrange indication is valid on the rising edge of the DCO.<br><br>Channel B LVDS Overrange Output—Complement. The overrange indication is valid on the rising edge of the DCO.                                                                                                                                                                         |

| Pin No.                          | Mnemonic        | Type         | Description                                                                                                                                                         |
|----------------------------------|-----------------|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 11                               | B D0-/D1- (LSB) | Output       | Channel B LVDS Output Data 1/Data 0—Complement.                                                                                                                     |
| 12                               | B D0+/D1+ (LSB) | Output       | Channel B LVDS Output Data 1/Data 0—True.                                                                                                                           |
| 13                               | B D2-/D3-       | Output       | Channel B LVDS Output Data 3/Data 2—Complement.                                                                                                                     |
| 14                               | B D2+/D3+       | Output       | Channel B LVDS Output Data 3/Data 2—True.                                                                                                                           |
| 15                               | B D4-/D5-       | Output       | Channel B LVDS Output Data 5/Data 4—Complement.                                                                                                                     |
| 16                               | B D4+/D5+       | Output       | Channel B LVDS Output Data 5/Data 4—True.                                                                                                                           |
| 17                               | B D6-/D7-       | Output       | Channel B LVDS Output Data 7/Data 6—Complement.                                                                                                                     |
| 18                               | B D6+/D7+       | Output       | Channel B LVDS Output Data 7/Data 6—True.                                                                                                                           |
| 20                               | B D8-/D9-       | Output       | Channel B LVDS Output Data 9/Data 8—Complement.                                                                                                                     |
| 21                               | B D8+/D9+       | Output       | Channel B LVDS Output Data 9/Data 8—True.                                                                                                                           |
| 22                               | B D10-/D11-     | Output       | Channel B LVDS Output Data 11/Data 10—Complement.                                                                                                                   |
| 23                               | B D10+/D11+     | Output       | Channel B LVDS Output Data 11/Data 10—True.                                                                                                                         |
| 29                               | A D0-/D1- (LSB) | Output       | Channel A LVDS Output Data 1/Data 0—Complement.                                                                                                                     |
| 30                               | A D0+/D1+ (LSB) | Output       | Channel A LVDS Output Data 1/Data 0—True.                                                                                                                           |
| 31                               | A D2-/D3-       | Output       | Channel A LVDS Output Data 3/Data 2—Complement.                                                                                                                     |
| 32                               | A D2+/D3+       | Output       | Channel A LVDS Output Data 3/Data 2—True.                                                                                                                           |
| 33                               | A D4-/D5-       | Output       | Channel A LVDS Output Data 5/Data 4—Complement.                                                                                                                     |
| 34                               | A D4+/D5+       | Output       | Channel A LVDS Output Data 5/Data 4—True.                                                                                                                           |
| 35                               | A D6-/D7-       | Output       | Channel A LVDS Output Data 7/Data 6—Complement.                                                                                                                     |
| 36                               | A D6+/D7+       | Output       | Channel A LVDS Output Data 7/Data 6—True.                                                                                                                           |
| 38                               | A D8-/D9-       | Output       | Channel A LVDS Output Data 9/Data 8—Complement.                                                                                                                     |
| 39                               | A D8+/D9+       | Output       | Channel A LVDS Output Data 9/Data 8—True.                                                                                                                           |
| 40                               | A D10-/D11-     | Output       | Channel A LVDS Output Data 11/Data 10—Complement.                                                                                                                   |
| 41                               | A D10+/D11+     | Output       | Channel A LVDS Output Data 11/Data 10—True.                                                                                                                         |
| 43                               | ORA+            | Output       | Channel A LVDS Overrange Output—True. The overrange indication is valid on the rising edge of the DCO.                                                              |
| 42                               | ORA-            | Output       | Channel A LVDS Overrange Output—Complement. The overrange indication is valid on the rising edge of the DCO.                                                        |
| 25                               | DCO+            | Output       | Channel A/Channel B LVDS Data Clock Output—True.                                                                                                                    |
| 24                               | DCO-            | Output       | Channel A/Channel B LVDS Data Clock Output—Complement.                                                                                                              |
| SPI Control                      |                 |              |                                                                                                                                                                     |
| 45                               | SCLK            | Input        | SPI Serial Clock.                                                                                                                                                   |
| 44                               | SDIO            | Input/Output | SPI Serial Data I/O.                                                                                                                                                |
| 46                               | CSB             | Input        | SPI Chip Select (Active Low).                                                                                                                                       |
| Output Enable Bar and Power-Down |                 |              |                                                                                                                                                                     |
| 47                               | OEB             | Input        | Output Enable Bar Input (Active Low).                                                                                                                               |
| 48                               | PDWN            | Input        | Power-Down Input (Active High). Operation depends upon SPI mode; this input can be configured as power-down or standby. For further description, refer to Table 14. |

## TYPICAL PERFORMANCE CHARACTERISTICS

AVDD = 1.8 V, DRVDD = 1.8 V, sample rate = maximum sample rate per speed grade, DCS enabled, 1.75 V p-p differential input, VIN = -1.0 dBFS, 32k sample, T<sub>A</sub> = 25°C, unless otherwise noted.

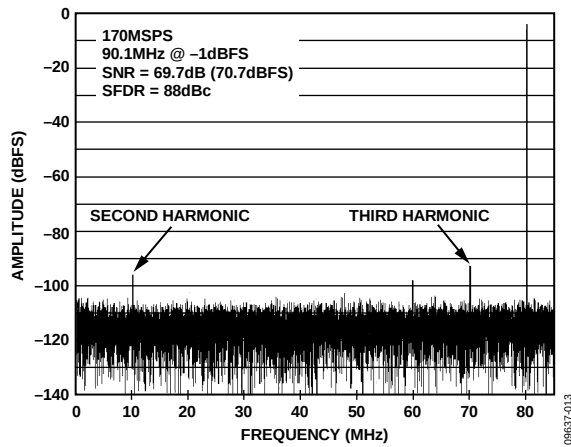


Figure 6. AD9613-170 Single-Tone FFT with  $f_{IN} = 90.1$  MHz

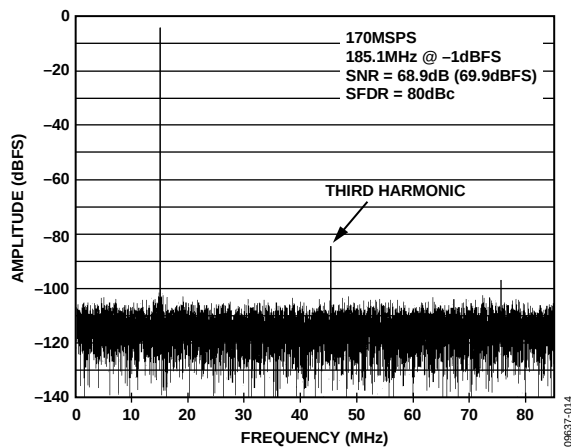


Figure 7. AD9613-170 Single-Tone FFT with  $f_{IN} = 185.1$  MHz

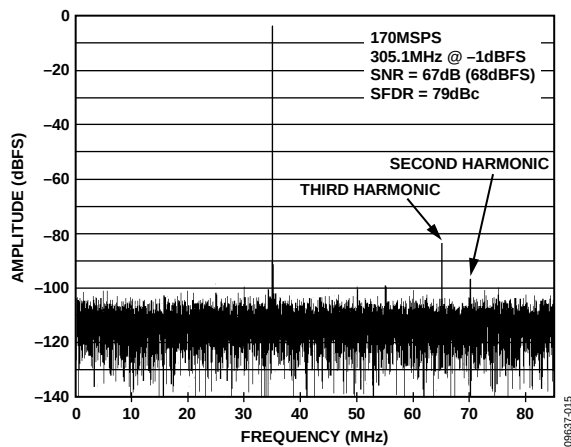


Figure 8. AD9613-170 Single-Tone FFT with  $f_{IN} = 305.1$  MHz

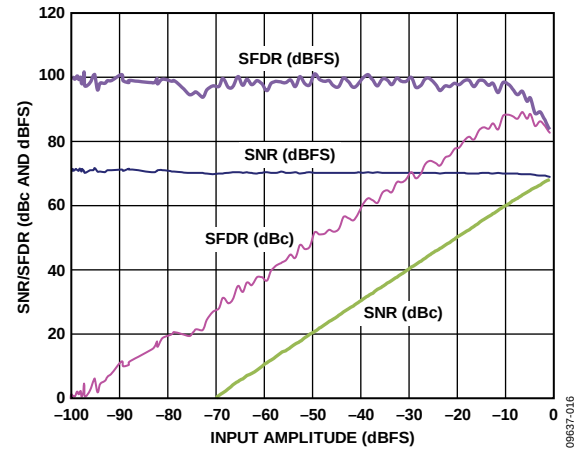


Figure 9. AD9613-170 Single-Tone SNR/SFDR vs. Input Amplitude ( $A_{IN}$ ) with  $f_{IN} = 90.1$  MHz

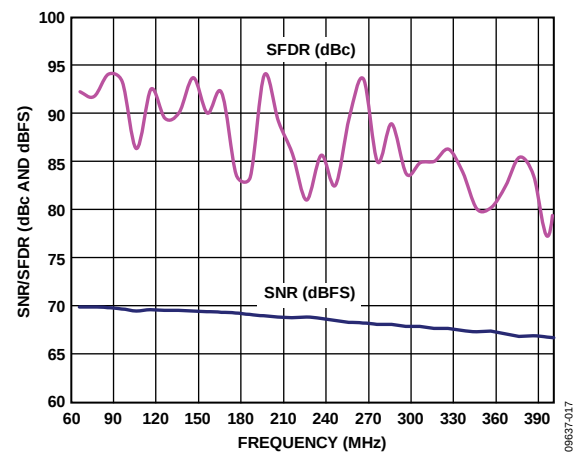


Figure 10. AD9613-170 Single-Tone SNR/SFDR vs. Input Frequency ( $f_{IN}$ )

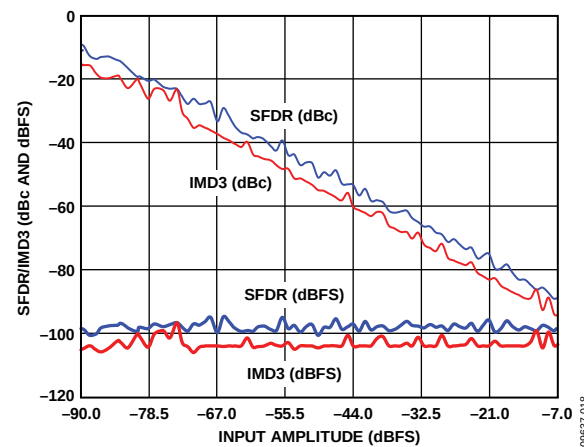


Figure 11. AD9613-170 Two-Tone SFDR/IMD3 vs. Input Amplitude ( $A_{IN}$ ) with  $f_{IN1} = 89.12$ ,  $f_{IN2} = 92.12$  MHz,  $f_s = 170$  MSPS

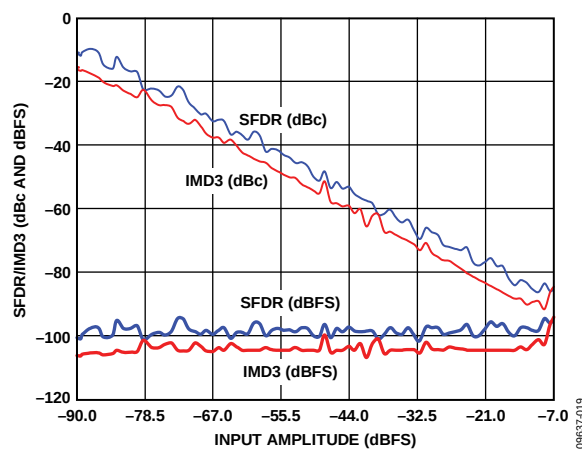


Figure 12. AD9613-170 Two-Tone SFDR/IMD3 vs. Input Amplitude ( $A_{IN}$ ) with  $f_{IN1} = 184.12$ ,  $f_{IN2} = 187.12$  MHz,  $f_s = 170$  MSPS

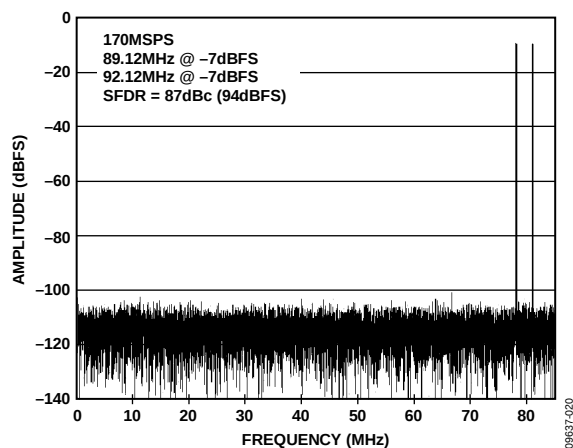


Figure 13. AD9613-170 Two-Tone FFT with  $f_{IN1} = 89.12$ ,  $f_{IN2} = 92.12$  MHz,  $f_s = 170$  MSPS

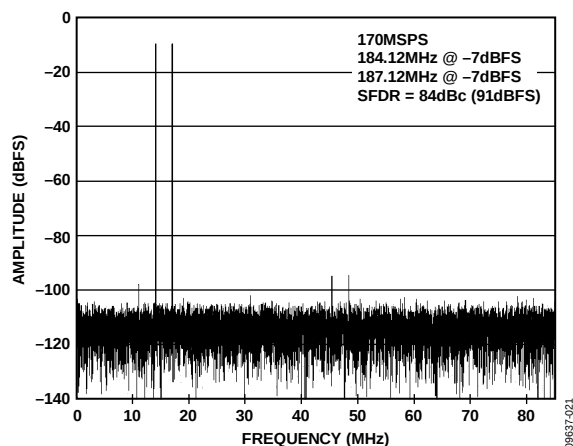


Figure 14. AD9613-170 Two-Tone FFT with  $f_{IN1} = 184.12$ ,  $f_{IN2} = 187.12$  MHz,  $f_s = 170$  MSPS

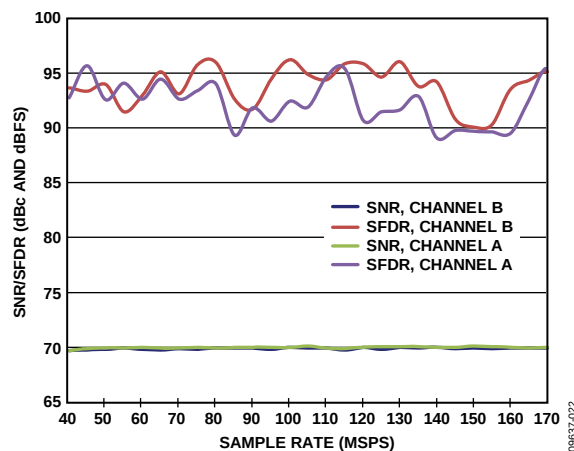


Figure 15. AD9613-170 Single-Tone SNR/SFDR vs. Sample Rate ( $f_s$ ) with  $f_{IN} = 90$  MHz

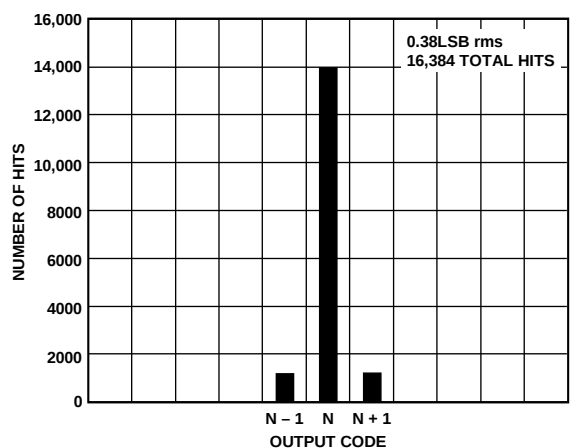


Figure 16. AD9613-170 Grounded Input Histogram

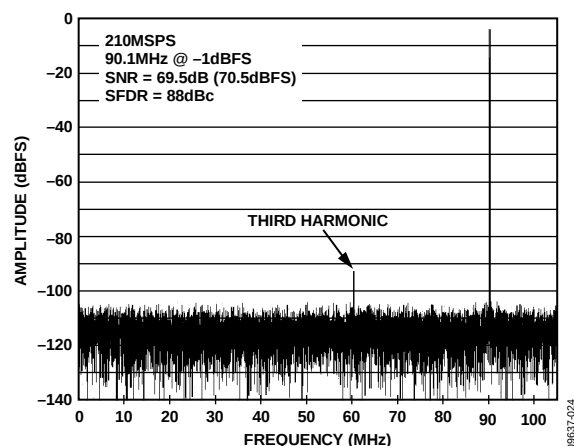
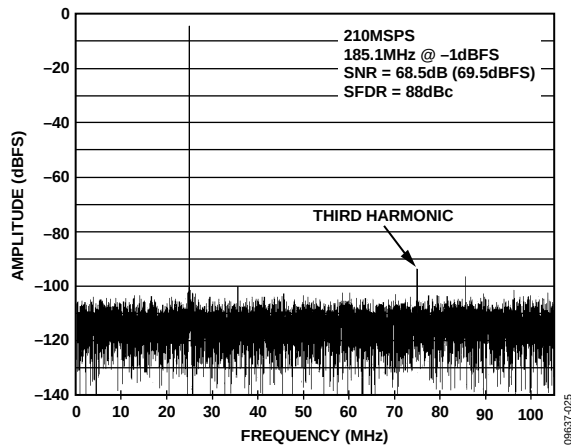
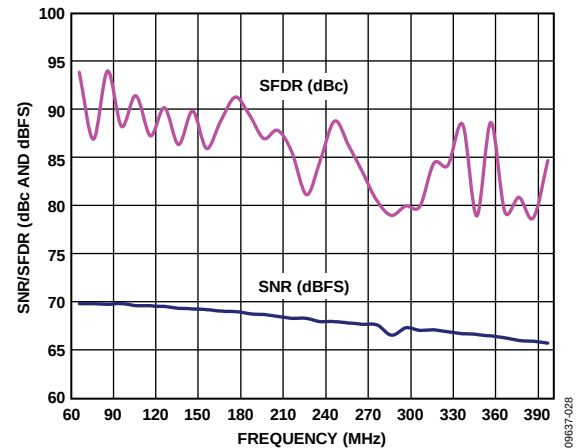
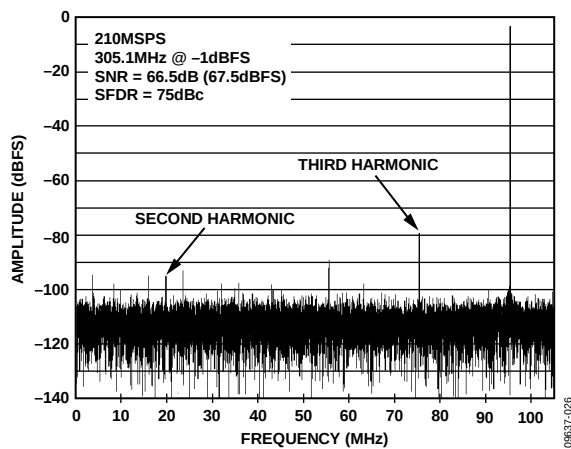
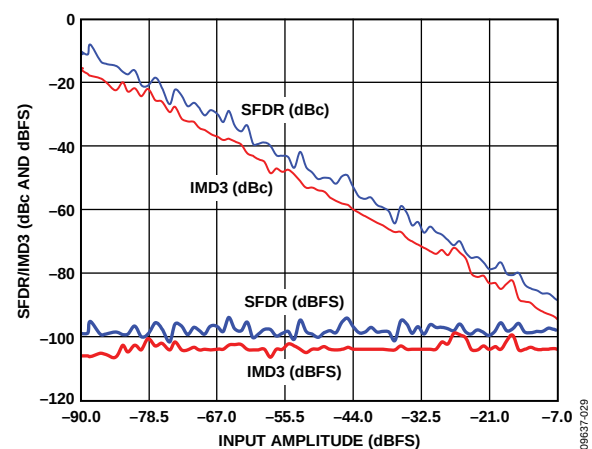
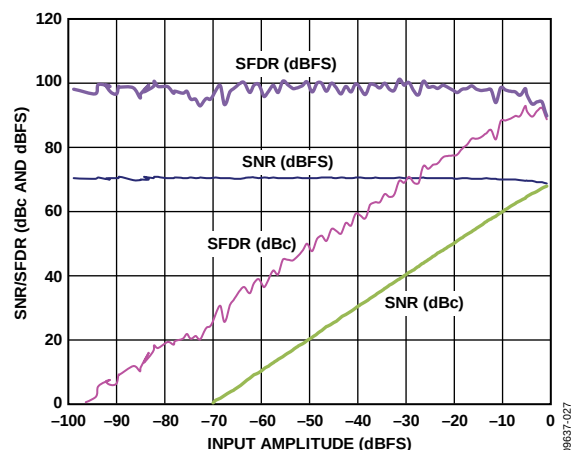
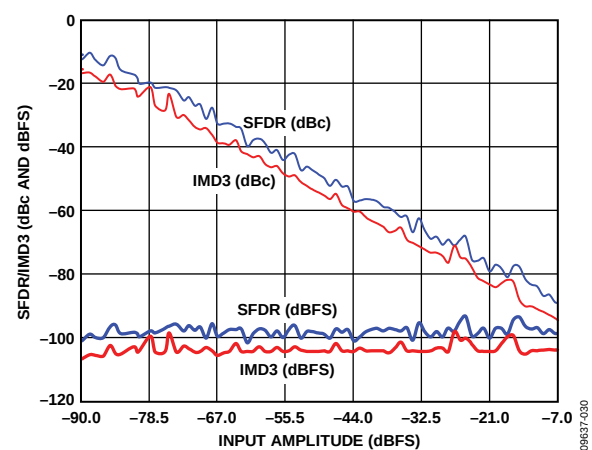


Figure 17. AD9613-210 Single-Tone FFT with  $f_{IN} = 90.1$  MHz

Figure 18. AD9613-210 Single-Tone FFT with  $f_{IN} = 185.1$  MHzFigure 21. AD9613-210 Single-Tone SNR/SFDR vs. Input Frequency ( $f_{IN}$ )Figure 19. AD9613-210 Single-Tone FFT with  $f_{IN} = 305.1$  MHzFigure 22. AD9613-210 Two-Tone SFDR/IMD3 vs. Input Amplitude ( $A_{IN}$ ) with  $f_{IN1} = 89.12$ ,  $f_{IN2} = 92.12$  MHz,  $f_s = 210$  MSPSFigure 20. AD9613-210 Single-Tone SNR/SFDR vs. Input Amplitude ( $A_{IN}$ ) with  $f_{IN} = 90.1$  MHzFigure 23. AD9613-210 Two-Tone SFDR/IMD3 vs. Input Amplitude ( $A_{IN}$ ) with  $f_{IN1} = 184.12$ ,  $f_{IN2} = 187.12$  MHz,  $f_s = 210$  MSPS

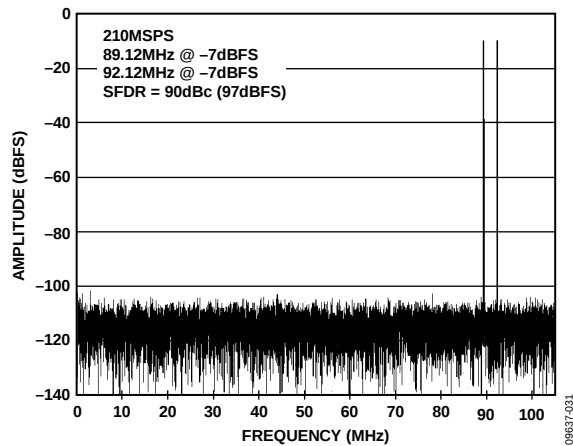


Figure 24. AD9613-210 Two-Tone FFT with  $f_{IN1} = 89.12$ ,  $f_{IN2} = 92.12$  MHz,  $f_s = 210$  MSPS

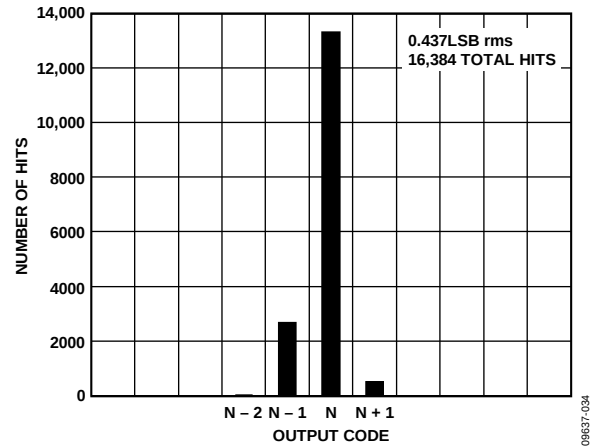


Figure 27. AD9613-210 Grounded Input Histogram

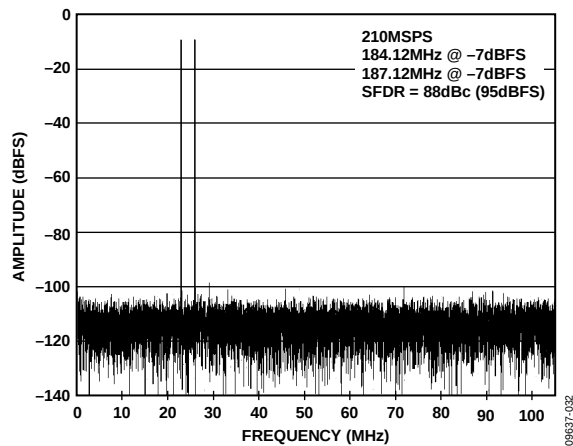


Figure 25. AD9613-210 Two-Tone FFT with  $f_{IN1} = 184.12$ ,  $f_{IN2} = 187.12$  MHz,  $f_s = 210$  MSPS

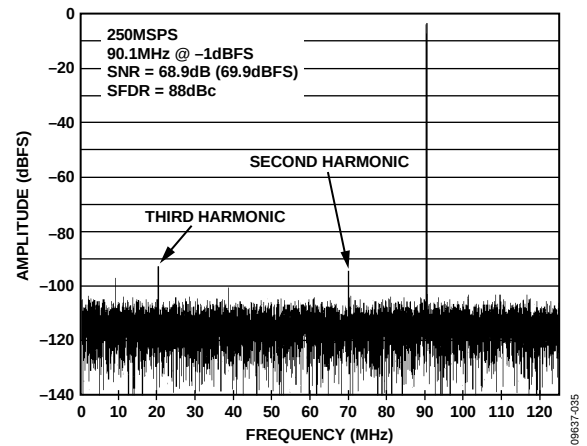


Figure 28. AD9613-250 Single-Tone FFT with  $f_{IN} = 90.1$  MHz

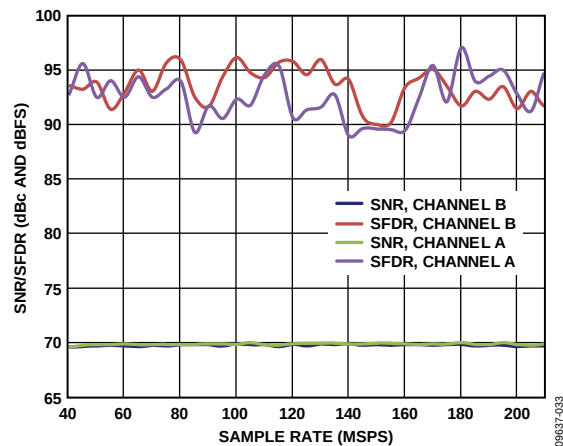


Figure 26. AD9613-210 Single-Tone SNR/SFDR vs. Sample Rate ( $f_s$ ) with  $f_{IN} = 90$  MHz

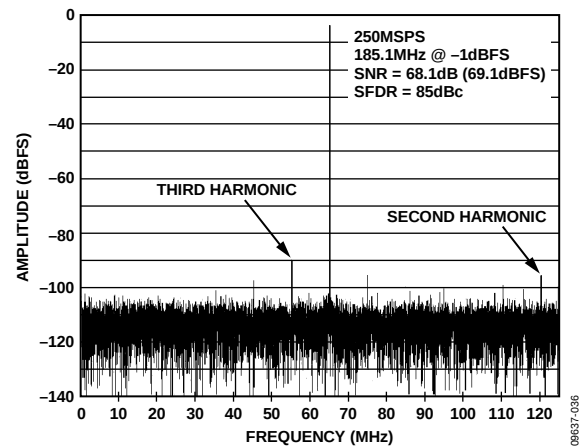
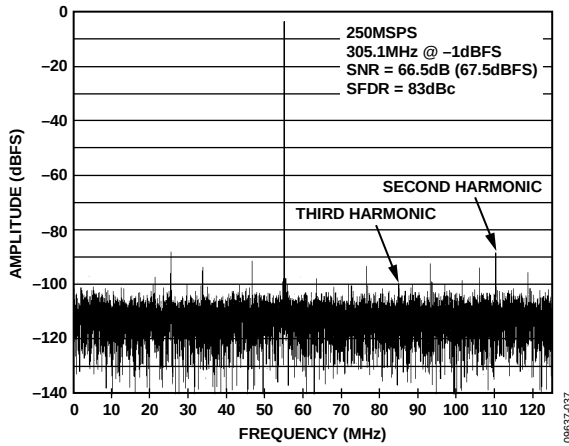
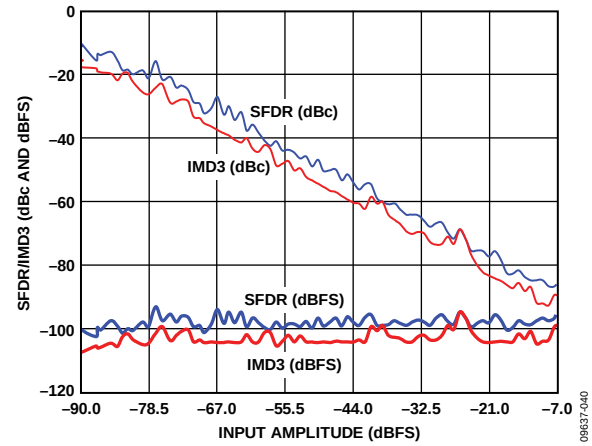
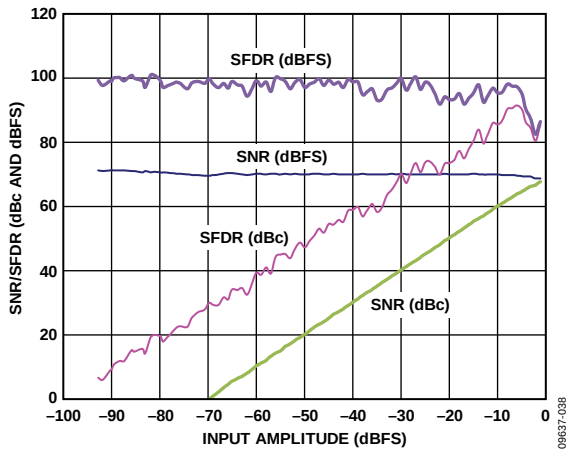
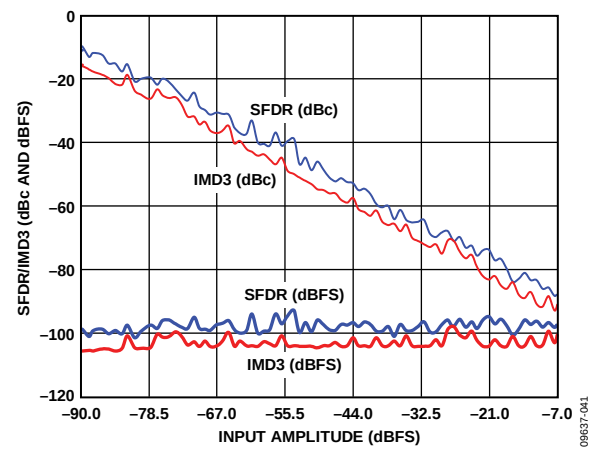
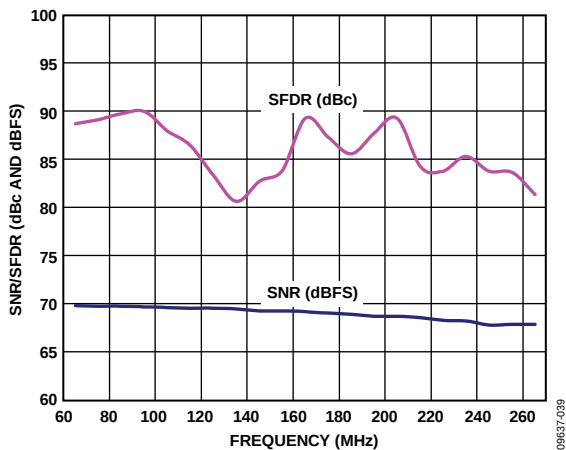
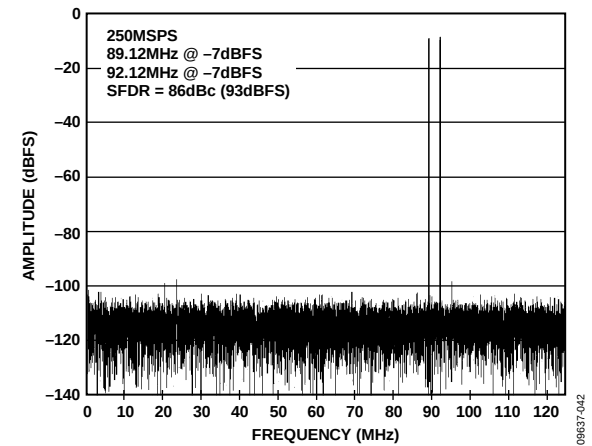


Figure 29. AD9613-250 Single-Tone FFT with  $f_{IN} = 185.1$  MHz

Figure 30. AD9613-250 Single-Tone FFT with  $f_{IN} = 305.1$  MHzFigure 33. AD9613-250 Two-Tone SFDR/IMD3 vs. Input Amplitude ( $A_{IN}$ ) with  $f_{IN1} = 89.12$ ,  $f_{IN2} = 92.12$  MHz,  $f_s = 250$  MSPSFigure 31. AD9613-250 Single-Tone SNR/SFDR vs. Input Amplitude ( $A_{IN}$ ) with  $f_{IN} = 90.1$  MHzFigure 34. AD9613-250 Two-Tone SFDR/IMD3 vs. Input Amplitude ( $A_{IN}$ ) with  $f_{IN1} = 184.12$ ,  $f_{IN2} = 187.12$  MHz,  $f_s = 250$  MSPSFigure 32. AD9613-250 Single-Tone SNR/SFDR vs. Input Frequency ( $f_{IN}$ )Figure 35. AD9613-250 Two-Tone FFT with  $f_{IN1} = 89.12$ ,  $f_{IN2} = 92.12$  MHz,  $f_s = 250$  MSPS

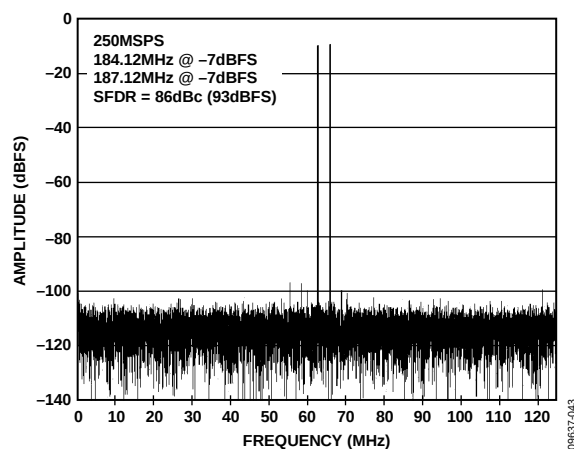


Figure 36. AD9613-250 Two-Tone FFT with  $f_{IN1} = 184.12$ ,  $f_{IN2} = 187.12$  MHz,  $f_s = 250$  MSPS

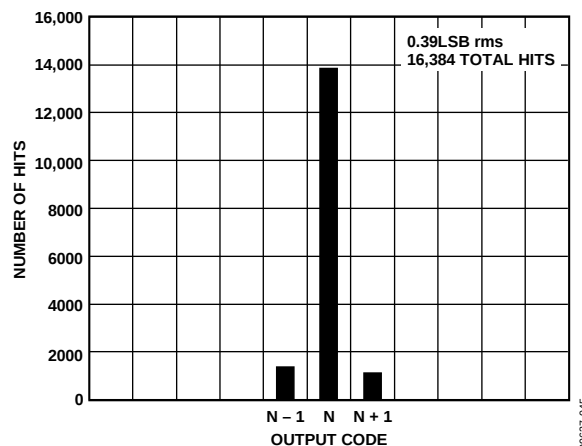


Figure 38. AD9613-250 Grounded Input Histogram

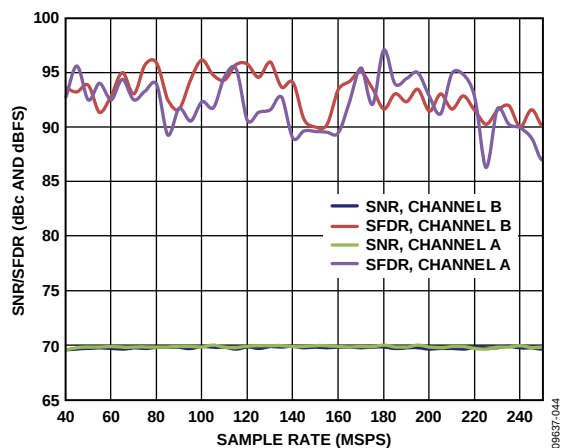


Figure 37. AD9613-250 Single-Tone SNR/SFDR vs. Sample Rate ( $f_s$ ) with  $f_{IN} = 90.1$  MHz

## EQUIVALENT CIRCUITS

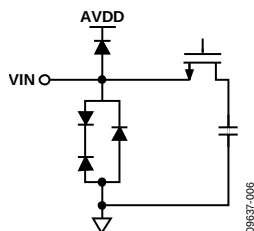


Figure 39. Equivalent Analog Input Circuit

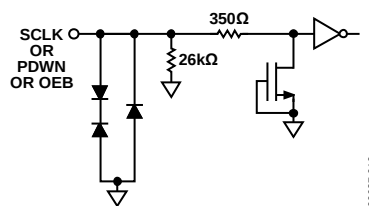


Figure 43. Equivalent SCLK, PDWN, or OEB Input Circuit

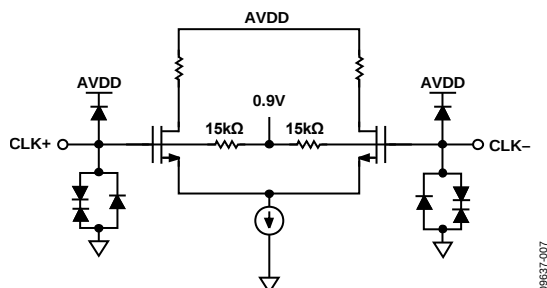


Figure 40. Equivalent Clock Input Circuit

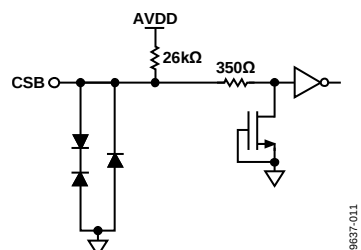


Figure 44. Equivalent CSB Input Circuit

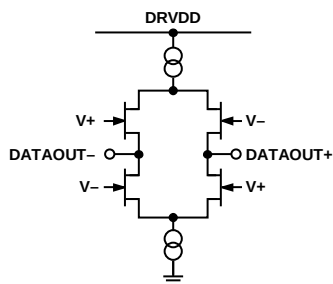


Figure 41. Equivalent LVDS Output Circuit

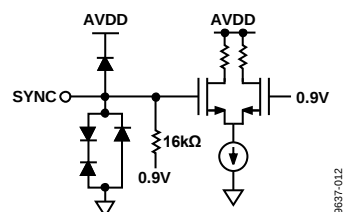


Figure 45. Equivalent SYNC Input Circuit

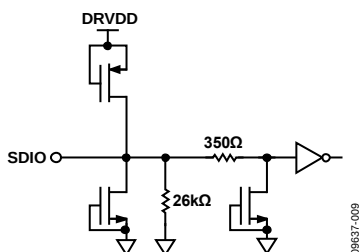


Figure 42. Equivalent SDIO Circuit

## THEORY OF OPERATION

The AD9613 has two analog input channels, two filter channels, and two digital output channels. The intermediate frequency (IF) input signal passes through several stages before appearing at the output port(s) as a filtered, and optionally, decimated digital signal.

The dual ADC design can be used for diversity reception of signals, where the ADCs operate identically on the same carrier but from two separate antennae. The ADCs can also be operated with independent analog inputs. The user can sample frequencies from dc to 300 MHz using appropriate low-pass or band-pass filtering at the ADC inputs with little loss in ADC performance. Operation to 400 MHz analog input is permitted but occurs at the expense of increased ADC noise and distortion.

Synchronization capability is provided to allow synchronized timing between multiple devices.

Programming and control of the AD9613 are accomplished using a 3-pin, SPI-compatible serial interface.

### ADC ARCHITECTURE

The AD9613 architecture consists of a dual front-end sample-and-hold circuit, followed by a pipelined, switched-capacitor ADC. The quantized outputs from each stage are combined into a final 12-bit result in the digital correction logic. The pipelined architecture permits the first stage to operate on a new input sample and the remaining stages to operate on the preceding samples. Sampling occurs on the rising edge of the clock.

Each stage of the pipeline, excluding the last, consists of a low resolution flash ADC connected to a switched-capacitor digital-to-analog converter (DAC) and an interstage residue amplifier (MDAC). The MDAC magnifies the difference between the reconstructed DAC output and the flash input for the next stage in the pipeline. One bit of redundancy is used in each stage to facilitate digital correction of flash errors. The last stage simply consists of a flash ADC.

The input stage of each channel contains a differential sampling circuit that can be ac- or dc-coupled in differential or single-ended modes. The output staging block aligns the data, corrects errors, and passes the data to the output buffers. The output buffers are powered from a separate supply, allowing digital output noise to be separated from the analog core. During power-down, the output buffers go into a high impedance state.

### ANALOG INPUT CONSIDERATIONS

The analog input to the AD9613 is a differential switched-capacitor circuit that has been designed for optimum performance while processing a differential input signal.

The clock signal alternatively switches the input between sample mode and hold mode (see the configuration shown in Figure 46). When the input is switched into sample mode, the signal source must be capable of charging the sampling capacitors and settling within 1/2 clock cycle.

A small resistor in series with each input can help reduce the peak transient current required from the output stage of the driving source. A shunt capacitor can be placed across the inputs to provide dynamic charging currents. This passive network creates a low-pass filter at the ADC input; therefore, the precise values are dependent on the application.

In intermediate frequency (IF) undersampling applications, the shunt capacitors should be reduced. In combination with the driving source impedance, the shunt capacitors limit the input bandwidth. Refer to the AN-742 Application Note, *Frequency Domain Response of Switched-Capacitor ADCs*; the AN-827 Application Note, *A Resonant Approach to Interfacing Amplifiers to Switched-Capacitor ADCs*; and the Analog Dialogue article, “Transformer-Coupled Front-End for Wideband A/D Converters,” for more information on this subject.

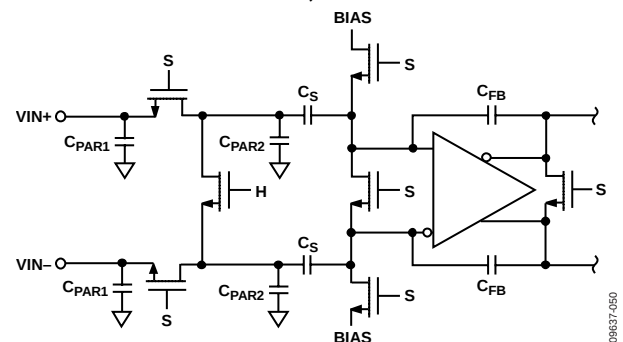


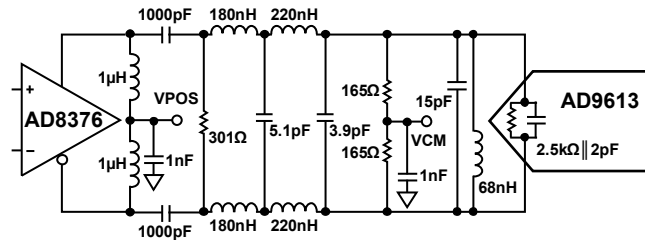
Figure 46. Switched-Capacitor Input

For best dynamic performance, the source impedances driving VIN+ and VIN- should be matched, and the inputs should be differentially balanced.

### Input Common Mode

The analog inputs of the AD9613 are not internally dc biased. In ac-coupled applications, the user must provide this bias externally. Setting the device so that  $V_{CM} = 0.5 \times AVDD$  (or 0.9 V) is recommended for optimum performance. An on-board common-mode voltage reference is included in the design and is available from the VCM pin. Using the VCM output to set the input common mode is recommended. Optimum performance is achieved when the common-mode voltage of the analog input is set by the VCM pin voltage (typically  $0.5 \times AVDD$ ). The VCM pin must be decoupled to ground by a 0.1  $\mu F$  capacitor, as described in the Applications Information section. Place this decoupling capacitor close to the pin to minimize the series resistance and inductance between the part and this capacitor.





## NOTES

1. ALL INDUCTORS ARE COILCRAFT 0603CS COMPONENTS WITH THE EXCEPTION OF THE 1μH CHOKE INDUCTORS (0603LS).
2. FILTER VALUES SHOWN FOR A 20MHz BANDWIDTH FILTER CENTERED AT 140MHz.

09637-054

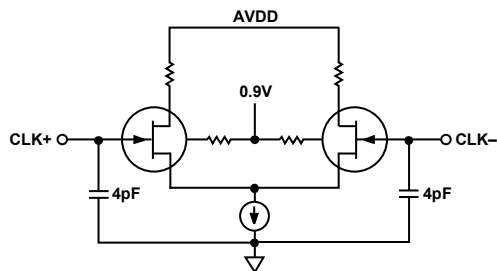
Figure 50. Differential Input Configuration Using the AD8376 (Filter Values Shown for a 20 MHz Bandwidth Filter Centered at 140 MHz)

## VOLTAGE REFERENCE

A stable and accurate voltage reference is built into the AD9613. The full-scale input range can be adjusted by varying the reference voltage via SPI. The input span of the ADC tracks reference voltage changes linearly.

## CLOCK INPUT CONSIDERATIONS

For optimum performance, the AD9613 sample clock inputs, CLK+ and CLK−, should be clocked with a differential signal. The signal is typically ac-coupled into the CLK+ and CLK− pins via a transformer or via capacitors. These pins are biased internally (see Figure 51) and require no external bias. If the inputs are floated, the CLK− pin is pulled low to prevent spurious clocking.



09637-055

Figure 51. Simplified Equivalent Clock Input Circuit

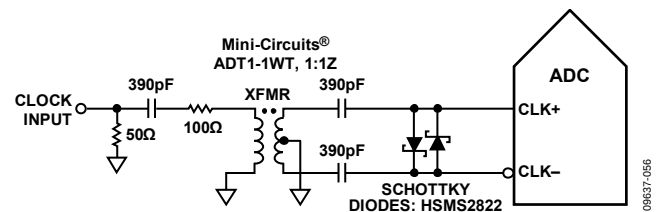
## Clock Input Options

The AD9613 has a very flexible clock input structure. Clock input can be a CMOS, LVDS, LVPECL, or sine wave signal. Regardless of the type of signal being used, clock source jitter is of the most concern, as described in the Jitter Considerations section.

Figure 52 and Figure 53 show two preferable methods for clocking the AD9613 (at clock rates of up to 625 MHz). A low jitter clock source is converted from a single-ended signal to a differential signal using an RF balun or RF transformer.

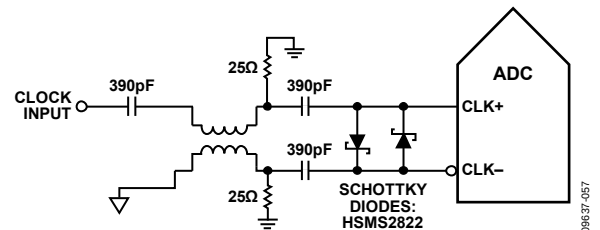
The RF balun configuration is recommended for clock frequencies between 125 MHz and 625 MHz, and the RF transformer is recommended for clock frequencies from 10 MHz to 200 MHz. The back-to-back Schottky diodes across the transformer secondary limit clock excursions into the AD9613 to approximately 0.8 V p-p differential. This limit helps prevent the large voltage swings of

the clock from feeding through to other portions of the AD9613, while preserving the fast rise and fall times of the signal, which are critical to low jitter performance.



09637-056

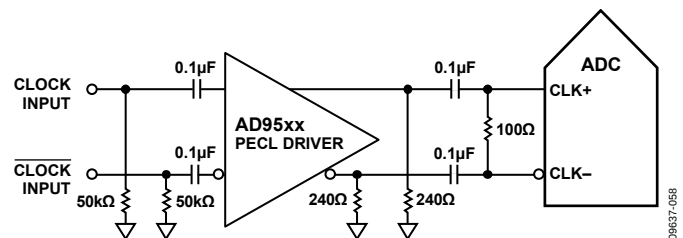
Figure 52. Transformer Coupled Differential Clock (Up to 200 MHz)



09637-057

Figure 53. Balun-Coupled Differential Clock (Up to 625 MHz)

If a low jitter clock source is not available, another option is to ac-couple a differential PECL signal to the sample clock input pins, as shown in Figure 54. The AD9510, AD9511, AD9512, AD9513, AD9514, AD9515, AD9516, AD9517, AD9518, AD9520, AD9522, AD9523, AD9524, and ADCLK905/ADCLK907/ADCLK925 clock drivers offer excellent jitter performance.



09637-058

Figure 54. Differential PECL Sample Clock (Up to 625 MHz)

A third option is to ac-couple a differential LVDS signal to the sample clock input pins, as shown in Figure 55. The AD9510, AD9511, AD9512, AD9513, AD9514, AD9515, AD9516, AD9517, AD9518, AD9520, AD9522, AD9523, and AD9524 clock drivers offer excellent jitter performance.

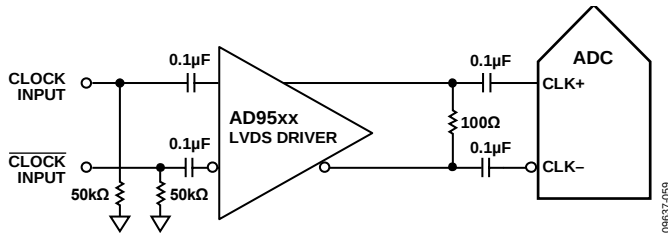


Figure 55. Differential LVDS Sample Clock (Up to 625 MHz)

### Input Clock Divider

The AD9613 contains an input clock divider with the ability to divide the input clock by integer values between 1 and 8. The duty cycle stabilizer (DCS) is enabled by default on power-up.

The AD9613 clock divider can be synchronized using the external SYNC input. Bit 1 and Bit 2 of Register 0x3A allow the clock divider to be resynchronized on every SYNC signal or only on the first SYNC signal after the register is written. A valid SYNC causes the clock divider to reset to its initial state. This synchronization feature allows multiple parts to have their clock dividers aligned to guarantee simultaneous input sampling.

### Clock Duty Cycle

Typical high speed ADCs use both clock edges to generate a variety of internal timing signals and, as a result, may be sensitive to clock duty cycle. Commonly, a  $\pm 5\%$  tolerance is required on the clock duty cycle to maintain dynamic performance characteristics.

The AD9613 contains a duty-cycle stabilizer (DCS) that retimes the nonsampling (falling) edge, providing an internal clock signal with a nominal 50% duty cycle. This allows the user to provide a wide range of clock input duty cycles without affecting the performance of the AD9613.

Jitter on the rising edge of the input clock is still of paramount concern and is not reduced by the duty cycle stabilizer. The duty cycle control loop does not function for clock rates less than 40 MHz nominally. The loop has a time constant associated with it that must be considered when the clock rate can change dynamically. A wait time of 1.5  $\mu\text{s}$  to 5  $\mu\text{s}$  is required after a dynamic clock frequency increase or decrease before the DCS loop is relocked to the input signal. During the period that the loop is not locked, the DCS loop is bypassed, and internal device timing is dependent on the duty cycle of the input clock signal. In such applications, it may be appropriate to disable the duty cycle stabilizer. In all other applications, enabling the DCS circuit is recommended to maximize ac performance.

### Jitter Considerations

High speed, high resolution ADCs are sensitive to the quality of the clock input. The degradation in SNR at a given input frequency ( $f_{\text{IN}}$ ) due to jitter ( $t_j$ ) can be calculated by

$$\text{SNR}_{\text{HF}} = -10 \log[(2\pi \times f_{\text{IN}} \times t_{\text{J RMS}})^2 + 10^{(-\text{SNR}_{\text{LF}}/10)}]$$

In the equation, the rms aperture jitter represents the root-mean-square of all jitter sources, which include the clock input, the analog input signal, and the ADC aperture jitter specification. IF undersampling applications are particularly sensitive to jitter, as shown in Figure 56.

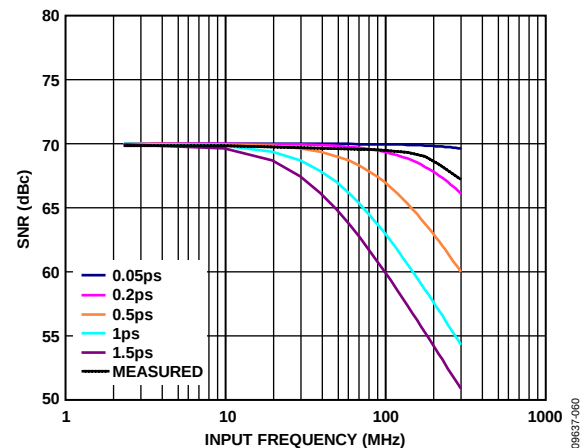


Figure 56. AD9613-250 SNR vs. Input Frequency and Jitter

The clock input should be treated as an analog signal in cases where aperture jitter may affect the dynamic range of the AD9613. Power supplies for clock drivers should be separated from the ADC output driver supplies to avoid modulating the clock signal with digital noise. Low jitter, crystal-controlled oscillators make the best clock sources. If the clock is generated from another type of source (by gating, dividing, or another method), it should be retimed by the original clock at the last step.

Refer to the AN-501 Application Note, *Aperture Uncertainty and ADC System Performance*, and the AN-756 Application Note, *Sample Systems and the Effects of Clock Phase Noise and Jitter*, for more information about jitter performance as it relates to ADCs.

## POWER DISSIPATION AND STANDBY MODE

As shown in Figure 57, the power dissipated by the AD9613 is proportional to its sample rate. The data in Figure 57 was taken using the same operating conditions as those used for the Typical Performance Characteristics section.

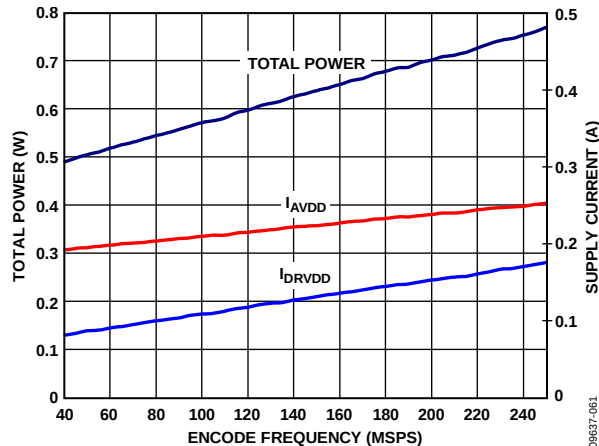


Figure 57. AD9613-250 Power and Current vs. Sample Rate

By asserting PDWN (either through the SPI port or by asserting the PDWN pin high), the AD9613 is placed in power-down mode. In this state, the ADC typically dissipates 10 mW. During power-down, the output drivers are placed in a high impedance state. Asserting the PDWN pin low returns the AD9613 to its normal operating mode. Note that PDWN is referenced to the digital output driver supply (DRVDD) and should not exceed that supply voltage.

Low power dissipation in power-down mode is achieved by shutting down the reference, reference buffer, biasing networks, and clock. Internal capacitors are discharged when entering power-down mode and then must be recharged when returning to normal operation. As a result, wake-up time is related to the time spent in power-down mode, and shorter power-down cycles result in proportionally shorter wake-up times.

When using the SPI port interface, the user can place the ADC in power-down mode or standby mode. Standby mode allows the user to keep the internal reference circuitry powered when faster wake-up times are required. See the Memory Map Register Description section and the AN-877 Application Note, *Interfacing to High Speed ADCs via SPI*, for additional details.

## DIGITAL OUTPUTS

The AD9613 output drivers can be configured for either ANSI LVDS or reduced drive LVDS using a 1.8 V DRVDD supply.

As detailed in Application Note AN-877, *Interfacing to High Speed ADCs via SPI*, the data format can be selected for offset binary, twos complement, or gray code when using the SPI control.

### Digital Output Enable Function (OEB)

The AD9613 has a flexible three-state ability for the digital output pins. The three-state mode is enabled using the OEB pin or through the SPI interface. If the OEB pin is low, the output data drivers are enabled. If the OEB pin is high, the output data drivers are placed in a high impedance state. This OEB function is not intended for rapid access to the data bus. Note that OEB is referenced to the digital output driver supply (DRVDD) and should not exceed that supply voltage.

When using the SPI interface, the data outputs of each channel can be independently three-stated by using the output enable bar bit (Bit 4) in Register 0x14. Because the output data is interleaved, if only one of the two channels is disabled, the output data of the remaining channel is repeated in both the rising and falling output clock cycles.

### Timing

The AD9613 provides latched data with a pipeline delay of 10 input sample clock cycles. Data outputs are available one propagation delay ( $t_{PD}$ ) after the rising edge of the clock signal.

Minimize the length of the output data lines and loads placed on them to reduce transients within the AD9613. These transients can degrade converter dynamic performance.

The lowest typical conversion rate of the AD9613 is 40 MSPS. At clock rates below 40 MSPS, dynamic performance can degrade.

### Data Clock Output (DCO)

The AD9613 also provides data clock output (DCO) intended for capturing the data in an external register. Figure 2 shows a timing diagram of the AD9613 output modes.

### ADC OVERRANGE (OR)

The ADC overrange indicator is asserted when an overrange is detected on the input of the ADC. The overrange condition is determined at the output of the ADC pipeline and, therefore, is subject to a latency of 10 ADC clock. An overrange at the input is indicated by this bit 10 clock cycles after it.

Table 11. Output Data Format

| Input (V)   | VIN+ – VIN–, Input Span = 1.75 V p-p (V) | Offset Binary Output Mode | Twos Complement Mode (Default) | OR |
|-------------|------------------------------------------|---------------------------|--------------------------------|----|
| VIN+ – VIN– | Less than –0.875                         | 0000 0000 0000            | 1000 0000 0000                 | 1  |
| VIN+ – VIN– | –0.875                                   | 0000 0000 0000            | 1000 0000 0000                 | 0  |
| VIN+ – VIN– | 0                                        | 1000 0000 0000            | 0000 0000 0000                 | 0  |
| VIN+ – VIN– | +0.875                                   | 1111 1111 1111            | 0111 1111 1111                 | 0  |
| VIN+ – VIN– | Greater than +0.875                      | 1111 1111 1111            | 0111 1111 1111                 | 1  |

## CHANNEL/CHIP SYNCHRONIZATION

The [AD9613](#) has a SYNC input that allows the user flexible synchronization options for synchronizing the internal blocks. The sync feature is useful for guaranteeing synchronized operation across multiple ADCs. The input clock divider can be synchronized using the SYNC input. The divider can be enabled to synchronize on a single occurrence of the SYNC signal or on every occurrence by setting the appropriate bits in Register 0x3A.

The SYNC input is internally synchronized to the sample clock. However, to ensure that there is no timing uncertainty between multiple parts, the SYNC input signal should be synchronized to the input clock signal. The SYNC input should be driven using a single-ended CMOS type signal.

## SERIAL PORT INTERFACE (SPI)

The [AD9613](#) SPI allows the user to configure the converter for specific functions or operations through a structured register space provided inside the ADC. The SPI gives the user added flexibility and customization, depending on the application. Addresses are accessed via the serial port and can be written to or read from via the port. Memory is organized into bytes that can be further divided into fields. These fields are documented in the Memory Map section. For detailed operational information, see the [AN-877](#) Application Note, *Interfacing to High Speed ADCs via SPI*.

### CONFIGURATION USING THE SPI

Three pins define the SPI of this ADC: the SCLK pin, the SDIO pin, and the CSB pin (see Table 12). The SCLK (serial clock) pin is used to synchronize the read and write data presented from/to the ADC. The SDIO (serial data input/output) pin is a dual-purpose pin that allows data to be sent and read from the internal ADC memory map registers. The CSB (chip select bar) pin is an active-low control that enables or disables the read and write cycles.

**Table 12. Serial Port Interface Pins**

| Pin  | Function                                                                                                                                                                            |
|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SCLK | Serial Clock. The serial shift clock input, which is used to synchronize serial interface reads and writes.                                                                         |
| SDIO | Serial Data Input/Output. A dual-purpose pin that typically serves as an input or an output, depending on the instruction being sent and the relative position in the timing frame. |
| CSB  | Chip Select Bar. An active-low control that gates the read and write cycles.                                                                                                        |

The falling edge of CSB, in conjunction with the rising edge of SCLK, determines the start of the framing. An example of the serial timing and its definitions can be found in Figure 58 and Table 5.

Other modes involving the CSB are available. The CSB can be held low indefinitely, which permanently enables the device; this is called streaming. The CSB can stall high between bytes to allow for additional external timing. When CSB is tied high, SPI functions are placed in a high impedance mode. This mode turns on any SPI pin secondary functions.

During an instruction phase, a 16-bit instruction is transmitted. Data follows the instruction phase and its length is determined by the W0 and W1 bits.

All data is composed of 8-bit words. The first bit of each individual byte of serial data indicates whether a read or write command is issued. This allows the serial data input/output (SDIO) pin to change direction from an input to an output.

In addition to word length, the instruction phase determines whether the serial frame is a read or write operation, allowing the serial port to be used both to program the chip and to read the contents of the on-chip memory. If the instruction is a readback operation, performing a readback causes the serial data input/output (SDIO) pin to change direction from an input to an output at the appropriate point in the serial frame.

Data can be sent in MSB-first mode or in LSB-first mode. MSB first is the default on power-up and can be changed via the SPI port configuration register. For more information about this and other features, see the [AN-877](#) Application Note, *Interfacing to High Speed ADCs via SPI*.

### HARDWARE INTERFACE

The pins described in Table 12 comprise the physical interface between the user programming device and the serial port of the [AD9613](#). The SCLK pin and the CSB pin function as inputs when using the SPI interface. The SDIO pin is bidirectional, functioning as an input during write phases and as an output during readback.

The SPI interface is flexible enough to be controlled by either FPGAs or microcontrollers. One method for SPI configuration is described in detail in the [AN-812](#) Application Note, *Microcontroller-Based Serial Port Interface (SPI) Boot Circuit*.

The SPI port should not be active during periods when the full dynamic performance of the converter is required. Because the SCLK signal, the CSB signal, and the SDIO signal are typically asynchronous to the ADC clock, noise from these signals can degrade converter performance. If the on-board SPI bus is used for other devices, it may be necessary to provide buffers between this bus and the [AD9613](#) to prevent these signals from transitioning at the converter inputs during critical sampling periods.

Table 13 provides a brief description of the general features that are accessible via the SPI. These features are described in detail in the [AN-877](#) Application Note, *Interfacing to High Speed ADCs via SPI*. The AD9613 part-specific features are described in the Memory Map Register Description section.

| Feature Name       | Description                                                         |
|--------------------|---------------------------------------------------------------------|
| Mode               | Allows the user to set either power-down mode or standby mode       |
| Clock              | Allows the user to access the DCS via the SPI                       |
| Offset             | Allows the user to digitally adjust the converter offset            |
| Test I/O           | Allows the user to set test modes to have known data on output bits |
| Output Mode        | Allows the user to set up outputs                                   |
| Output Phase       | Allows the user to set the output clock polarity                    |
| Output Delay       | Allows the user to vary the DCO delay                               |
| VREF               | Allows the user to set the reference voltage                        |
| Digital Processing | Allows the user to enable the synchronization features              |



## MEMORY MAP

### READING THE MEMORY MAP REGISTER TABLE

Each row in the memory map register table has eight bit locations. The memory map is roughly divided into four sections: the chip configuration registers (Address 0x00 to Address 0x02); the channel index and transfer registers (Address 0x05 and Address 0xFF); and the ADC functions registers, including setup, control, and test (Address 0x08 to Address 0x3A).

The memory map register table (see Table 14) documents the default hexadecimal value for each hexadecimal address shown. The column with the heading Bit 7 (MSB) is the start of the default hexadecimal value given. For example, Address 0x14, the output mode register, has a hexadecimal default value of 0x05. This means that Bit 0 = 1 and Bit 2 = 1, and the remaining bits are 0s. This setting is the default output format value, which is twos complement. For more information on this function and others, see the [AN-877](#) Application Note, *Interfacing to High Speed ADCs via SPI*. This document details the functions controlled by Register 0x00 to Register 0x20. The remaining register, Register 0x3A, is documented in the Memory Map Register Description section.

### Open and Reserved Locations

All address and bit locations that are not included in Table 14 are not currently supported for this device. Unused bits of a valid address location should be written with 0s. Writing to these locations is required only when part of an address location is open (for example, Address 0x18). If the entire address location is open (for example, Address 0x13), this address location should not be written.

### Default Values

After the [AD9613](#) is reset, critical registers are loaded with default values. The default values for the registers are given in the memory map register table (see Table 14).

### Logic Levels

An explanation of logic level terminology follows:

- “Bit is set” is synonymous with “bit is set to Logic 1” or “writing Logic 1 for the bit.”
- “Clear a bit” is synonymous with “bit is set to Logic 0” or “writing Logic 0 for the bit.”

### Transfer Register Map

Address 0x08 to Address 0x20 and Address 0x3A are shadowed. Writes to these addresses do not affect part operation until a transfer command is issued by writing 0x01 to Address 0xFF, setting the transfer bit. This allows these registers to be updated internally and simultaneously when the transfer bit is set. The internal update takes place when the transfer bit is set and the bit aut clears.

### Channel Specific Registers

Some channel setup functions, such as the signal monitor thresholds, can be programmed to a different value for each channel. In these cases, channel address locations are internally duplicated for each channel. These registers and bits are designated in Table 14 as local. These local registers and bits can be accessed by setting the appropriate Channel A or Channel B bits in Register 0x05. If both bits are set, the subsequent write affects the registers of both channels. In a read cycle, only Channel A or Channel B should be set to read one of the two registers. If both bits are set during an SPI read cycle, the part returns the value for Channel A. Registers and bits designated as global in Table 14 affect the entire part and the channel features for which independent settings are not allowed between channels. The settings in Register 0x05 do not affect the global registers and bits.

## MEMORY MAP REGISTER TABLE

All address and bit locations that are not included in Table 14 are not currently supported for this device.

Table 14. Memory Map Registers

| Addr (Hex)                           | Register Name                                | Bit 7 (MSB)                                  | Bit 6     | Bit 5                                                                                                                                                                                                                                                               | Bit 4 | Bit 3 | Bit 2                                                                                                                                                                                      | Bit 1                                                                                                              | Bit 0 (LSB)                     | Default Value (Hex) | Default Notes/Comments                                                                                              |
|--------------------------------------|----------------------------------------------|----------------------------------------------|-----------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------|---------------------------------|---------------------|---------------------------------------------------------------------------------------------------------------------|
| Chip Configuration Registers         |                                              |                                              |           |                                                                                                                                                                                                                                                                     |       |       |                                                                                                                                                                                            |                                                                                                                    |                                 |                     |                                                                                                                     |
| 0x00                                 | SPI port configuration (global) <sup>1</sup> | 0                                            | LSB first | Soft reset                                                                                                                                                                                                                                                          | 1     | 1     | Soft reset                                                                                                                                                                                 | LSB first                                                                                                          | 0                               | 0x18                | The nibbles are mirrored so that LSB-first mode or MSB-first mode registers correctly, regardless of shift mode     |
| 0x01                                 | Chip ID (global)                             | 8-bit chip ID[7:0] (AD9613 = 0x83) (default) |           |                                                                                                                                                                                                                                                                     |       |       |                                                                                                                                                                                            |                                                                                                                    |                                 | 0x83                | Read only                                                                                                           |
| 0x02                                 | Chip grade (global)                          | Open                                         | Open      | Speed grade ID<br>00 = 250 MSPS<br>01 = 210 MSPS<br>11 = 170 MSPS                                                                                                                                                                                                   | Open  | Open  | Open                                                                                                                                                                                       | Open                                                                                                               | Open                            |                     | Speed grade ID used to differentiate devices; read only                                                             |
| Channel Index and Transfer Registers |                                              |                                              |           |                                                                                                                                                                                                                                                                     |       |       |                                                                                                                                                                                            |                                                                                                                    |                                 |                     |                                                                                                                     |
| 0x05                                 | Channel index (global)                       | Open                                         | Open      | Open                                                                                                                                                                                                                                                                | Open  | Open  | Open                                                                                                                                                                                       | ADC B (default)                                                                                                    | ADC A (default)                 | 0x03                | Bits are set to determine which device on the chip receives the next write command; applies to local registers only |
| 0xFF                                 | Transfer (global)                            | Open                                         | Open      | Open                                                                                                                                                                                                                                                                | Open  | Open  | Open                                                                                                                                                                                       | Open                                                                                                               | Transfer                        | 0x00                | Synchronously transfers data from the master shift register to the slave                                            |
| ADC Functions                        |                                              |                                              |           |                                                                                                                                                                                                                                                                     |       |       |                                                                                                                                                                                            |                                                                                                                    |                                 |                     |                                                                                                                     |
| 0x08                                 | Power modes (local)                          | Open                                         | Open      | External power-down pin function (local)<br>0 = power-down<br>1 = standby                                                                                                                                                                                           | Open  | Open  | Open                                                                                                                                                                                       | Internal power-down mode (local)<br>00 = normal operation<br>01 = full power-down<br>10 = standby<br>11 = reserved |                                 | 0x00                | Determines various generic modes of chip operation                                                                  |
| 0x09                                 | Global clock (global)                        | Open                                         | Open      | Open                                                                                                                                                                                                                                                                | Open  | Open  | Open                                                                                                                                                                                       | Open                                                                                                               | Duty cycle stabilizer (default) | 0x01                |                                                                                                                     |
| 0x0B                                 | Clock divide (global)                        | Open                                         | Open      | Input clock divider phase adjust<br>000 = no delay<br>001 = 1 input clock cycle<br>010 = 2 input clock cycles<br>011 = 3 input clock cycles<br>100 = 4 input clock cycles<br>101 = 5 input clock cycles<br>110 = 6 input clock cycles<br>111 = 7 input clock cycles |       |       | Clock divide ratio<br>000 = divide by 1<br>001 = divide by 2<br>010 = divide by 3<br>011 = divide by 4<br>100 = divide by 5<br>101 = divide by 6<br>110 = divide by 7<br>111 = divide by 8 |                                                                                                                    |                                 | 0x00                | Clock divide values other than 000 automatically cause the duty cycle stabilizer to become active                   |

| Addr (Hex) | Register Name                    | Bit 7 (MSB)                                                                             | Bit 6 | Bit 5                                                          | Bit 4                                                                                                                                                                        | Bit 3                                                                                                                                                                                                                                                                                                                                                                                                      | Bit 2                                                         | Bit 1                                                                                                            | Bit 0 (LSB) | Default Value (Hex)                          | Default Notes/ Comments                                                                       |
|------------|----------------------------------|-----------------------------------------------------------------------------------------|-------|----------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------|-------------|----------------------------------------------|-----------------------------------------------------------------------------------------------|
| 0x0D       | Test mode (local)                | User test mode control<br>0 = continuouus/repeat pattern<br>1 = single pattern, then 0s | Open  | Reset PN long gen                                              | Reset PN short gen                                                                                                                                                           | Output test mode<br>0000 = off (default)<br>0001 = midscale short<br>0010 = positive FS<br>0011 = negative FS<br>0100 = alternating checkerboard<br>0101 = PN long sequence<br>0110 = PN short sequence<br>0111 = one/zero word toggle<br>1000 = user test mode<br>1001 to 1110 = unused<br>1111 = ramp output                                                                                             |                                                               |                                                                                                                  |             | 0x00                                         | When this register is set, the test data is placed on the output pins in place of normal data |
| 0x10       | Offset adjust (local)            | Open                                                                                    | Open  | Offset adjust in LSBs from +31 to -32 (twos complement format) |                                                                                                                                                                              |                                                                                                                                                                                                                                                                                                                                                                                                            |                                                               |                                                                                                                  |             | 0x00                                         |                                                                                               |
| 0x14       | Output mode                      | Open                                                                                    | Open  | Open                                                           | Output enable bar (local)                                                                                                                                                    | Open                                                                                                                                                                                                                                                                                                                                                                                                       | Output invert (local)<br>1 = normal (default)<br>0 = inverted | Output format<br>00 = offset binary<br>01 = twos complement (default)<br>10 = gray code<br>11 = reserved (local) |             | 0x05                                         | Configures the outputs and the format of the data                                             |
| 0x15       | Output Adjust (Global)           | Open                                                                                    | Open  | Open                                                           | Open                                                                                                                                                                         | LVDS output drive current adjust<br>0000 = 3.72 mA output drive current<br>0001 = 3.5 mA output drive current (default)<br>0010 = 3.30 mA output drive current<br>0011 = 2.96 mA output drive current<br>0100 = 2.82 mA output drive current<br>0101 = 2.57 mA output drive current<br>0110 = 2.27 mA output drive current<br>0111 = 2.0 mA output drive current (reduced range)<br>1000 - 1111 = reserved |                                                               |                                                                                                                  |             | 0x01                                         |                                                                                               |
| 0x16       | Clock phase control (global)     | Invert DCO clock                                                                        | Open  | Odd/Even Mode Output Enable<br>0 = disabled<br>1 = enabled     | Open                                                                                                                                                                         | Open                                                                                                                                                                                                                                                                                                                                                                                                       | Open                                                          | Open                                                                                                             | Open        | 0x00                                         |                                                                                               |
| 0x17       | DCO output delay (global)        | Enable DCO clock delay                                                                  | Open  | Open                                                           | DCO clock delay<br>[delay = (3100 ps × register value/31 + 100)]<br>00000 = 100 ps<br>00001 = 200 ps<br>00010 = 300 ps<br>...<br>11110 = 3100 ps<br>11111 = 3200 ps          |                                                                                                                                                                                                                                                                                                                                                                                                            |                                                               |                                                                                                                  | 0x00        |                                              |                                                                                               |
| 0x18       | Input span select (global)       | Open                                                                                    | Open  | Open                                                           | Full-scale input voltage selection<br>01111 = 2.087 V p-p<br>...<br>00001 = 1.772 V p-p<br>00000 = 1.75 V p-p (default)<br>11111 = 1.727 V p-p<br>...<br>10000 = 1.383 V p-p |                                                                                                                                                                                                                                                                                                                                                                                                            |                                                               |                                                                                                                  | 0x00        | Full-scale input adjustment in 0.022 V steps |                                                                                               |
| 0x19       | User Test Pattern 1 LSB (global) | User Test Pattern 1[7:0]                                                                |       |                                                                |                                                                                                                                                                              |                                                                                                                                                                                                                                                                                                                                                                                                            |                                                               |                                                                                                                  |             | 0x00                                         |                                                                                               |
| 0x1A       | User Test Pattern 1 MSB (global) | User Test Pattern 1[15:8]                                                               |       |                                                                |                                                                                                                                                                              |                                                                                                                                                                                                                                                                                                                                                                                                            |                                                               |                                                                                                                  |             | 0x00                                         |                                                                                               |
| 0x1B       | User Test Pattern 2 LSB (global) | User Test Pattern 2[7:0]                                                                |       |                                                                |                                                                                                                                                                              |                                                                                                                                                                                                                                                                                                                                                                                                            |                                                               |                                                                                                                  |             | 0x00                                         |                                                                                               |
| 0x1C       | User Test Pattern 2 MSB (global) | User Test Pattern 2[15:8]                                                               |       |                                                                |                                                                                                                                                                              |                                                                                                                                                                                                                                                                                                                                                                                                            |                                                               |                                                                                                                  |             | 0x00                                         |                                                                                               |
| 0x1D       | User Test Pattern 3 LSB (global) | User Test Pattern 3[7:0]                                                                |       |                                                                |                                                                                                                                                                              |                                                                                                                                                                                                                                                                                                                                                                                                            |                                                               |                                                                                                                  |             | 0x00                                         |                                                                                               |

| Addr (Hex) | Register Name                    | Bit 7 (MSB)               | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2                        | Bit 1                     | Bit 0 (LSB)               | Default Value (Hex) | Default Notes/Comments |
|------------|----------------------------------|---------------------------|-------|-------|-------|-------|------------------------------|---------------------------|---------------------------|---------------------|------------------------|
| 0x1E       | User Test Pattern 3 MSB (global) | User Test Pattern 3[15:8] |       |       |       |       |                              |                           |                           | 0x00                |                        |
| 0x1F       | User Test Pattern 4 LSB (global) | User Test Pattern 4[7:0]  |       |       |       |       |                              |                           |                           | 0x00                |                        |
| 0x3A       | Sync control (global)            | Open                      | Open  | Open  | Open  | Open  | Clock divider next sync only | Clock divider sync enable | Master sync buffer enable | 0x00                |                        |

<sup>1</sup> The channel index register at Address 0x05 should be set to 0x03 (default) when writing to Address 0x00.

## MEMORY MAP REGISTER DESCRIPTION

For more information on functions controlled in Register 0x00 to Register 0x20, see the [AN-877](#) Application Note, *Interfacing to High Speed ADCs via SPI*.

### Sync Control (Register 0x3A)

#### Bits[7:3]—Reserved

#### Bit 2—Clock Divider Next Sync Only

If the master sync buffer enable bit (Address 0x3A, Bit 0) and the clock divider sync enable bit (Address 0x3A, Bit 1) are high, Bit 2 allows the clock divider to sync to the first sync pulse that

it receives and to ignore the rest. The clock divider sync enable bit (Address 0x3A, Bit 1) resets after it syncs.

#### Bit 1—Clock Divider Sync Enable

Bit 1 gates the sync pulse to the clock divider. The sync signal is enabled when Bit 1 is high and Bit 0 is high. This is continuous sync mode.

#### Bit 0—Master Sync Buffer Enable

Bit 0 must be set high to enable any of the sync functions. If the sync capability is not used, this bit should remain low to conserve power.

## APPLICATIONS INFORMATION

### DESIGN GUIDELINES

Before starting system-level design and layout of the [AD9613](#), it is recommended that the designer become familiar with these guidelines, which discuss the special circuit connections and layout requirements needed for certain pins.

#### **Power and Ground Recommendations**

When connecting power to the [AD9613](#), it is recommended that two separate 1.8 V supplies be used: one supply should be used for analog (AVDD), and a separate supply should be used for the digital outputs (DRVDD). The designer can employ several different decoupling capacitors to cover both high and low frequencies. These capacitors should be located close to the point of entry at the PC board level and close to the pins of the part with minimal trace length.

A single PCB ground plane should be sufficient when using the [AD9613](#). With proper decoupling and smart partitioning of the PCB analog, digital, and clock sections, optimum performance is easily achieved.

#### **Exposed Paddle Thermal Heat Slug Recommendations**

It is mandatory that the exposed paddle on the underside of the ADC be connected to analog ground (AGND) to achieve the best electrical and thermal performance. A continuous, exposed (no solder mask) copper plane on the PCB should mate to the [AD9613](#) exposed paddle, Pin 0.

The copper plane should have several vias to achieve the lowest possible resistive thermal path for heat dissipation to flow through the bottom of the PCB. These vias should be filled or plugged with nonconductive epoxy.

To maximize the coverage and adhesion between the ADC and the PCB, a silkscreen should be overlaid to partition the continuous plane on the PCB into several uniform sections. This provides several tie points between the ADC and the PCB during the reflow process. Using one continuous plane with no partitions guarantees only one tie point between the ADC and the PCB. See the evaluation board for a PCB layout example. For detailed information about the packaging and PCB layout of chip-scale packages, refer to the AN-772 Application Note, *A Design and Manufacturing Guide for the Lead Frame Chip Scale Package (LFCSP)*.

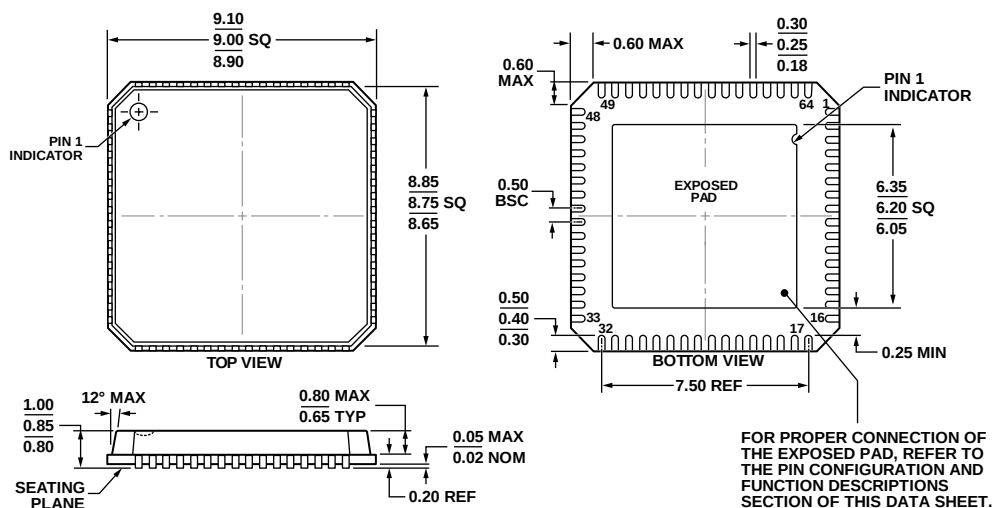
#### **VCM**

The VCM pin should be decoupled to ground with a 0.1  $\mu\text{F}$  capacitor, as shown in Figure 48. For optimal channel-to-channel isolation, a 33  $\Omega$  resistor should be included between the [AD9613](#) VCM pin and the Channel A analog input network connection, as well as between the [AD9613](#) VCM pin and the Channel B analog input network connection.

#### **SPI Port**

The SPI port should not be active during periods when the full dynamic performance of the converter is required. Because the SCLK, CSB, and SDIO signals are typically asynchronous to the ADC clock, noise from these signals can degrade converter performance. If the on-board SPI bus is used for other devices, it may be necessary to provide buffers between this bus and the [AD9613](#) to keep these signals from transitioning at the converter input pins during critical sampling periods.

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-VMMD-4

Figure 59. 64-Lead Lead Frame Chip Scale Package [LFCSP\_VQ]  
 9 mm × 9 mm Body, Very Thin Quad  
 (CP-64-4)  
 Dimensions shown in millimeters

06-12-2012-C

## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description                                        | Package Option |
|--------------------|-------------------|------------------------------------------------------------|----------------|
| AD9613BCPZ-170     | −40°C to +85°C    | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ], 170 MSPS | CP-64-4        |
| AD9613BCPZ-210     | −40°C to +85°C    | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ], 210 MSPS | CP-64-4        |
| AD9613BCPZ-250     | −40°C to +85°C    | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ], 250 MSPS | CP-64-4        |
| AD9613BCPZRL7-170  | −40°C to +85°C    | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ], 170 MSPS | CP-64-4        |
| AD9613BCPZRL7-210  | −40°C to +85°C    | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ], 210 MSPS | CP-64-4        |
| AD9613BCPZRL7-250  | −40°C to +85°C    | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ], 250 MSPS | CP-64-4        |
| AD9613-170EBZ      |                   | Evaluation Board with AD9613, 170 MSPS                     |                |
| AD9613-210EBZ      |                   | Evaluation Board with AD9613, 210 MSPS                     |                |
| AD9613-250EBZ      |                   | Evaluation Board with AD9613, 250 MSPS                     |                |

<sup>1</sup> Z = RoHS Compliant Part.